



ADS8327 ADS8328

www.ti.com

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

# LOW POWER, 16-BIT, 500-kHz, SINGLE/DUAL UNIPOLAR INPUT, ANALOG-TO-DIGITAL CONVERTERS WITH SERIAL INTERFACE

Check for Samples: ADS8327, ADS8328

# FEATURES

- 2.7-V to 5.5-V Analog Supply, Low Power:
  - 10.6 mW (500 kHz, +VA = 2.7 V, +VBD = 1.8 V)
- 500-kHz Sampling Rate
- Excellent DC Performance
  - ±1.5 LSB Typ, ±2 LSB Max INL
  - ±0.6 LSB Typ, ±1 LSB Max DNL
  - 16-Bit NMC Over Temperature
  - $\pm 0.5 \text{ mV}$  Max Offset Error at 2.7 V
  - ±1 mV Max Offset Error at 5 V
- Excellent AC Performance at f<sub>I</sub> = 10 kHz with 91 dB SNR, 100 dB SFDR, –96 dB THD
- Built-In Conversion Clock (CCLK)
- 1.65 V to 1.5×(+VA) I/O Supply
  - SPI/DSP Compatible Serial
  - SCLK up to 50 MHz
- Comprehensive Power-Down Modes:
  - Deep Power-Down
  - Nap Power-Down
  - Auto Nap Power-Down
- Unipolar Input Range: 0 V to V<sub>REF</sub>
- Software Reset
- Global CONVST (Independent of CS)
- Programmable Status/Polarity EOC/INT
- 16-Pin 4×4 QFN or 16-Pin TSSOP Packages
- Multi-Chip Daisy Chain Mode
- Programmable TAG Bit Output
- Auto/Manual Channel Select Mode

# **APPLICATIONS**

- Communications
- Transducer Interface
- Medical Instruments
- Magnetometers
- Industrial Process Control
- Data Acquisition Systems
- Automatic Test Equipment

# DESCRIPTION

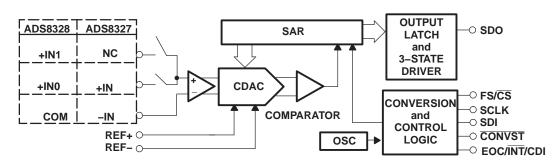
The ADS8327 is a low power, 16-bit, 500-kSPS analog-to-digital converter with a unipolar input. The device includes a 16-bit capacitor-based SAR A/D converter with inherent sample and hold.

The ADS8328 is based on the same core and includes a 2-to-1 input MUX with programmable option of TAG bit output. Both the ADS8327 and ADS8328 offer a high-speed, wide voltage serial interface and are capable of chain mode operation when multiple converters are used.

These converters are available in a 16-lead TSSOP or 4x4 QFN packages and are fully specified for operation over the industrial  $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range.

## Table 1. Low Power, High-Speed SAR Converter Family

| Type/Spee          | 500 kHz | 1 MHz   |         |
|--------------------|---------|---------|---------|
| 16 Dit Dooudo Diff | Single  | ADS8327 | ADS8329 |
| 16 Bit Pseudo-Diff | Dual    | ADS8328 | ADS8330 |





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

# ADS8327 ADS8328



## SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

|           | 1   |   | _                                  |                 | -                     |                      | 1                       |                                |                         |                       |                         |
|-----------|---|---|------------------------------------|-----------------|-----------------------|----------------------|-------------------------|--------------------------------|-------------------------|-----------------------|-------------------------|
| MODEL     | MAXIMUM<br>INTEGRAL<br>LINEARITY<br>(LSB) | MAXIMUM<br>DIFFERENTIAL<br>LINEARITY<br>(LSB) | MAXIMUM<br>OFFSET<br>ERROR<br>(mV) | PACKAGE<br>TYPE | PACKAGE<br>DESIGNATOR | TEMPERATURE<br>RANGE | ORDERING<br>INFORMATION | TRANSPORT<br>MEDIA<br>QUANTITY |                         |                       |                         |
|           |   |   |                                    |                 |                       |                      | ADS8327IPW              | Tube 90                        |                         |                       |                         |
|           |   |   |                                    | TSSOP-16        | PW                    |                      | ADS8327IPWR             | Tape and reel<br>2000          |                         |                       |                         |
| ADS83271  | ±3  | -1/+2   | ±1.25                              | 4×4 QFN-16      | RSA                   | -40°C to +85°C       | ADS8327IRSAT            | Small tape and reel 250        |                         |                       |                         |
|           |   |   |                                    | 4*4 QFN-10      | KSA                   |                      | ADS8327IRSAR            | Tape and reel<br>3000          |                         |                       |                         |
|           |   |   |                                    |                 |                       |                      | ADS8327IBPW             | Tube 90                        |                         |                       |                         |
|           |   |   |                                    | TSSOP-16        | PW                    |                      | ADS8327IBPWR            | Tape and reel<br>2000          |                         |                       |                         |
| ADS8327IB | ±2  | ±1  | ±1                                 | 4×4 QFN-16 RSA  |                       |                      | -40°C to +85°C          | ADS8327IBRSAT                  | Small tape and reel 250 |                       |                         |
|           |   |   |                                    | 4×4 QFN-16      | RSA                   |                      | ADS8327IBRSAR           | Tape and reel<br>3000          |                         |                       |                         |
|           |   |   |                                    |                 |                       |                      | ADS8328IPW              | Tube 90                        |                         |                       |                         |
|           |   |   |                                    | TSSOP-16        | PW                    |                      | ADS8328IPWR             | Tape and reel<br>2000          |                         |                       |                         |
| ADS8328I  | ±3  | -1/+2   | ±1.25                              |                 |                       |                      |                         |                                | -40°C to +85°C          | ADS8328IRSAT          | Small tape and reel 250 |
|           |   |   |                                    | 4×4 QFN-16      | RSA                   |                      | ADS8328IRSAR            | Tape and reel<br>3000          |                         |                       |                         |
|           |   |   |                                    |                 |                       |                      | ADS8328IBPW             | Tube 90                        |                         |                       |                         |
|           |   |   |                                    | TSSOP-16        | TSSOP-16              | TSSOP-16 PW          | TSSOP-16 PW             |                                | ADS8328IBPWR            | Tape and reel<br>2000 |                         |
| ADS8328IB | ±2  | ±1  | ±1                                 |                 |                       | -40°C to +85°C       | ADS8328IBRSAT           | Small tape and reel 250        |                         |                       |                         |
|           |   |   |                                    | 4×4 QEN-16      | 4×4 QFN-16 RSA        |                      | RSA                     |                                | ADS8328IBRSAR           | Tape and reel<br>3000 |                         |

## **ORDERING INFORMATION**<sup>(1)</sup>

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at www.ti.com.



SLAS415E - APRIL 2006 - REVISED JANUARY 2011

#### www.ti.com

## **ABSOLUTE MAXIMUM RATINGS**

Over operating free-air temperature range, unless otherwise noted.<sup>(1)</sup>

|                        |                   |                                 | UNIT   |
|------------------------|-------------------|---------------------------------|--|
| Volta                  | 20                | +IN to AGND                     | –0.3 V to +VA + 0.3 V                                  |
| Volta                  | ige               | -IN to AGND                     | –0.3 V to +VA + 0.3 V                                  |
|                        |                   | +VA to AGND                     | –0.3 V to 7 V  |
|                        |                   | +REF to AGND                    | –0.3 V to +VA + 0.3 V                                  |
| Volta                  | ige range         | -REF to AGND                    | –0.3 V to +0.3 V                                       |
|                        |                   | +VBD to BDGND                   | –0.3 V to 7 V  |
|                        |                   | AGND to BDGND                   | –0.3 V to 0.3 V  |
| Digita                 | al input voltage  | to BDGND                        | -0.3 V to +VBD + 0.3 V                                 |
| Digita                 | al output voltag  | e to BDGND                      | -0.3 V to +VBD + 0.3 V                                 |
| T <sub>A</sub> Oper    | ating free-air te | emperature range                | -40°C to +85°C   |
| T <sub>stg</sub> Stora | age temperatur    | e range                         | –65°C to +150°C  |
| Junc                   | tion temperatu    | re (T <sub>J</sub> max)         | +150°C   |
| TSS                    | OP-16             | Power dissipation               | (T <sub>J</sub> Max - T <sub>A</sub> )/θ <sub>JA</sub> |
| Pack                   | age               | $\theta_{JA}$ thermal impedance | 86°C/W   |
| 4×4 (                  | QFN-16            | Power dissipation               | $(T_JMax - T_A)/\theta_{JA}$                           |
| Pack                   | age               | $\theta_{JA}$ thermal impedance | 47°C/W   |

(1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SLAS415E - APRIL 2006-REVISED JANUARY 2011



www.ti.com

# **SPECIFICATIONS**

 $T_A = -40^{\circ}C$  to 85°C, +VA = 2.7 V to 3.6 V, +VBD = 1.65 V to 1.5 × (+VA),  $V_{REF} = 2.5$  V, and  $f_{SAMPLE} = 500$  kHz, unless otherwise noted.

|                      | PARAMET                     | TER                     | TEST CONDITIONS                     | MIN        | TYP   | MAX               | UNIT               |
|----------------------|-----------------------------|-------------------------|-------------------------------------|------------|-------|-------------------|--------------------|
| ANALOG               |                             |                         |                                     | ·          |       |                   |                    |
|                      | Full-scale input vo         | ltage <sup>(1)</sup>    | +IN – (–IN) or (+INx – COM)         | 0          |       | +V <sub>REF</sub> | V                  |
|                      |                             |                         | +IN, +IN0, +IN1                     | AGND - 0.2 |       | +VA + 0.2         | .,                 |
|                      | Absolute input volt         | age                     | –IN or COM                          | AGND - 0.2 |       | AGND + 0.2        | V                  |
|                      | Input capacitance           |                         |                                     |            | 40    | 45                | pF                 |
|                      | Input leakage curre         | ent                     | No ongoing conversion,<br>DC Input  | -1         |       | 1                 | nA                 |
|                      | Innut channel isola         | tion ADS2220 only       | At dc                               |            | 108   |                   | dB                 |
|                      | input channel isola         | ation, ADS8328 only     | $V_I = \pm 1.25 V_{PP}$ at 50 kHz   |            | 101   |                   | uв                 |
| SYSTEM               | PERFORMANCE                 |                         | •                                   |            |       |                   |                    |
|                      | Resolution                  |                         |                                     |            | 16    |                   | Bits               |
|                      | No missing codes            |                         |                                     | 16         |       |                   | Bits               |
| INL                  | Integral linearity          | ADS8327IB,<br>ADS8328IB |                                     | -2         | ±1.2  | 2                 | LSB <sup>(2)</sup> |
|                      | 0 ,                         | ADS8327I, ADS8328I      |                                     | -3         | ±2    | 3                 |                    |
| DNL                  | Differential                | ADS8327IB,<br>ADS8328IB |                                     | -1         | ±0.6  | 1                 | LSB <sup>(2)</sup> |
|                      | linearity                   | ADS8327I, ADS8328I      |                                     | -1         | ±1    | 2                 |                    |
| Eo                   | Offset error <sup>(3)</sup> | ADS8327IB,<br>ADS8328IB |                                     | -0.5       | ±0.1  | 0.5               | mV                 |
| -                    |                             | ADS8327I, ADS8328I      |                                     | -0.8       | ±0.1  | 0.8               |                    |
|                      | Offset error drift          |                         |                                     |            | 0.2   |                   | ppm/°C             |
| E <sub>G</sub>       | Gain error                  |                         |                                     | -0.25      | -0.07 | 0.25              | %FSR               |
|                      | Gain error drift            |                         |                                     |            | 0.3   |                   | ppm/°C             |
| CMRR                 | Common modo roi             | ination ratio           | At dc                               |            | 70    |                   | dB                 |
| CIVIRR               | Common-mode rej             |                         | $V_{I} = 0.4 V_{PP}$ at 1 MHz       |            | 50    |                   | uВ                 |
|                      | Noise                       |                         |                                     |            | 33    |                   | $\mu V RMS$        |
| PSRR                 | Power-supply reject         | ction ratio             | At FFFFh output code <sup>(3)</sup> |            | 78    |                   | dB                 |
| SAMPLIN              | NG DYNAMICS                 |                         |                                     |            |       |                   |                    |
| t <sub>CONV</sub>    | Conversion time             |                         |                                     |            | 18    |                   | CCLK               |
| t <sub>SAMPLE1</sub> | A convicition time          |                         | Manual trigger                      | 3          |       |                   | COLK               |
| t <sub>SAMPLE2</sub> | Acquisition time            |                         | Auto trigger                        |            | 3     |                   | CCLK               |
|                      | Throughput rate             |                         |                                     |            |       | 500               | kHz                |
|                      | Aperture delay              |                         |                                     |            | 5     |                   | ns                 |
|                      | Aperture jitter             |                         |                                     |            | 10    |                   | ps                 |
|                      | Step response               |                         |                                     |            | 100   |                   | ns                 |
|                      | Overvoltage recov           | ery                     |                                     |            | 100   |                   | ns                 |

Ideal input span, does not include gain or offset error. (1)

LSB means least significant bit.

(2) (3) Measured relative to an ideal full-scale input [+IN - (-IN)] of 2.5 V when +VA = 2.7 V. EXAS STRUMENTS

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

## **SPECIFICATIONS** (continued)

 $T_A = -40^{\circ}C$  to 85°C, +VA = 2.7 V to 3.6 V, +VBD = 1.65 V to 1.5 × (+VA),  $V_{REF} = 2.5$  V, and  $f_{SAMPLE} = 500$  kHz, unless otherwise noted.

|                  | PARAMET                    | ER                             | TEST CONDITIONS  | MIN           | TYP   | MAX           | UNIT |
|------------------|----------------------------|--------------------------------|--|---------------|-------|---------------|------|
| DYNAMIC          | C CHARACTERISTIC           | s                              |  |               |       |               |      |
| THD              | Total harmonic dist        | tartian (4)                    | $V_{IN}$ = 2.5 $V_{PP}$ at 10 kHz                                  |               | -98   |               | dB   |
| IND              | Total narmonic dis         |                                | V <sub>IN</sub> = 2.5 V <sub>PP</sub> at 100 kHz                   |               | -83.5 |               | uБ   |
|                  |                            | -                              | $V_{IN} = 2.5 V_{PP}$ at 10 kHz                                    |               | 88.5  |               | -ID  |
| SNR              | Signal-to-noise rati       | 0                              | V <sub>IN</sub> = 2.5 V <sub>PP</sub> at 100 kHz                   |               | 85    |               | dB   |
|                  | 0                          |                                | $V_{IN} = 2.5 V_{PP}$ at 10 kHz                                    |               | 88.5  |               | 10   |
| SINAD            | Signal-to-noise + d        | listortion                     | V <sub>IN</sub> = 2.5 V <sub>PP</sub> at 100 kHz                   |               | 81    |               | dB   |
| 0500             |                            |                                | V <sub>IN</sub> = 2.5 V <sub>PP</sub> at 10 kHz                    |               | 101   |               | 10   |
| SFDR             | Spurious-free dyna         | amic range                     | V <sub>IN</sub> = 2.5 V <sub>PP</sub> at 100 kHz                   |               | 84    |               | dB   |
|                  | –3dB small-signal l        | bandwidth                      |  |               | 30    |               | MHz  |
| CLOCK            |                            |                                |  |               |       | ·             |      |
|                  | Internal conversion        | n clock frequency              |  | 10.5          | 11    | 12.2          | MHz  |
|                  | SCLK External serial clock |                                | Used as I/O clock only   |               |       | 33            |      |
|                  |                            |                                | As I/O clock and conversion clock                                  | 1             |       | 21            | MHz  |
| EXTERN           | AL VOLTAGE REFER           | RENCE INPUT                    | +  | ľ             |       | L.            |      |
|                  | Input reference            | V <sub>REF</sub> (REF+ – REF–) | 3.6 V ≥ +VA ≥ 2.7 V  | 0.3           |       | 2.525         |      |
| V <sub>REF</sub> | range                      | (REF–) – AGND                  |  | -0.1          |       | 0.1           | V    |
|                  | Resistance (5)             | 1                              | Reference input  |               | 80    |               | kΩ   |
| DIGITAL          | INPUT/OUTPUT               |                                | <u>+</u> · ·   | 4             |       |               |      |
|                  | Logic family—CMC           | DS                             |  |               |       |               |      |
| VIH              | High-level input vo        |                                | (+VA × 1.5) V ≥ +VBD ≥ 1.65 V                                      | 0.65 × (+VBD) |       | +VBD + 0.3    | V    |
| VIL              | Low-level input vol        | tage                           | (+VA × 1.5) V ≥ +VBD ≥ 1.65 V                                      | -0.3          |       | 0.35 × (+VBD) | V    |
| <u>l</u> i       | Input current              |                                | V <sub>I</sub> = +VBD or BDGND                                     | -50           |       | 50            | nA   |
| C                | Input capacitance          |                                |  |               | 5     |               | pF   |
| V <sub>OH</sub>  | High-level output v        | oltage                         | $(+VA \times 1.5) V \ge +VBD \ge 1.65 V,$<br>$I_{O} = 100 \ \mu A$ | +VBD – 0.6    |       | +VBD          | V    |
| V <sub>OL</sub>  | Low-level output vo        | oltage                         | $(+VA \times 1.5) V \ge +VBD \ge 1.65 V,$<br>$I_0 = 100 \ \mu A$   | 0             |       | 0.4           | V    |
| Co               | Output capacitance         | e                              |  |               | 5     |               | pF   |
| CL               | Load capacitance           |                                |  |               |       | 30            | pF   |
|                  | Data format—straig         | ght binary                     |  |               |       |               |      |
| POWER-           | SUPPLY REQUIREM            | ENTS                           |  |               |       | l             |      |
|                  | Power-supply               | +VBD                           |  | 1.65          | +VA   | 1.5 × (+VA)   | V    |
|                  | voltage                    | +VA                            |  | 2.7           |       | 3.6           | V    |
|                  |                            | 1                              | 500-kHz Sample rate  |               | 3.8   | 5             |      |
|                  | Supply current             |                                | NAP/Auto-NAP mode  |               | 0.2   | 0.4           | mA   |
|                  |                            |                                | Deep power-down mode   |               | 2     | 50            | nA   |
|                  | Buffer I/O supply c        | urrent                         | 500 kSPS   |               | 0.2   |               | mA   |
|                  | Power dissipation          |                                | +VA = 2.7 V, +VBD = 1.8 V  |               | 10.6  | 14            | mW   |
| TEMPER           | ATURE RANGE                |                                |  | 1             |       |               |      |
| T <sub>A</sub>   | Operating free-air t       | tomporaturo                    |  | -40           |       | +85           | °C   |

(4) Calculated on the first nine harmonics of the input frequency.(5) Can vary ±30%.



SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

## **SPECIFICATIONS**

 $T_{A} = -40^{\circ}C \text{ to } 85^{\circ}C, +VA = 4.5 \text{ V to } 5.5 \text{ V}, +VBD = 1.65 \text{ V to } 5.5 \text{ V}, \text{ } \text{V}_{\text{REF}} = 4.096 \text{ V}, \text{ and } f_{\text{SAMPLE}} = 500 \text{ kHz}, \text{ unless otherwise}$ noted.

|                       | PARAN                       | IETER                   | TEST CONDITIONS                     | MIN        | TYP   | MAX               | UNIT               |
|-----------------------|-----------------------------|-------------------------|-------------------------------------|------------|-------|-------------------|--------------------|
| ANALOG I              | INPUT                       |                         |                                     |            |       |                   |                    |
| F                     | Full-scale input v          | oltage (1)              | +IN – (–IN) or (+INx – COM)         | 0          |       | +V <sub>REF</sub> | V                  |
|                       |                             |                         | +IN, +IN0, +IN1                     | AGND – 0.2 |       | +VA + 0.2         |                    |
| А                     | Absolute input voltage      |                         | -IN or COM                          | AGND – 0.2 |       | AGND + 0.2        | V                  |
| Ir                    | nput capacitance            | e                       |                                     |            | 40    | 45                | pF                 |
| Ir                    | nput leakage cu             | rrent                   | No ongoing conversion,<br>DC Input  | -1         |       | 1                 | nA                 |
| 1.                    |                             |                         | At dc                               |            | 109   |                   | -ID                |
| Ir                    | nput channel isc            | lation, ADS8328 only    | $V_I = \pm 1.25 V_{PP}$ at 50 kHz   |            | 101   |                   | dB                 |
| SYSTEM F              | PERFORMANCI                 |                         |                                     |            |       |                   |                    |
| R                     | Resolution                  |                         |                                     |            | 16    |                   | Bits               |
| Ν                     | No missing code             | s                       |                                     | 16         |       |                   | Bits               |
| INL Ir                | ntegral linearity           | ADS8327IB,<br>ADS8328IB |                                     | -2         | ±1.5  | 2                 | LSB <sup>(2)</sup> |
|                       | 0                           | ADS8327I, ADS8328I      |                                     | -3         | ±2    | 3                 |                    |
|                       | Differential                | ADS8327IB,<br>ADS8328IB |                                     | -1         | ±0.7  | 1                 | LSB <sup>(2)</sup> |
| I                     | linearity                   | ADS8327I, ADS8328I      |                                     | -1         | ±1    | 2                 |                    |
| E <sub>O</sub> C      | Offset error <sup>(3)</sup> | ADS8327IB,<br>ADS8328IB |                                     | -1         | ±0.4  | 1                 | mV                 |
| -                     |                             | ADS8327I, ADS8328I      |                                     | -1.25      | ±0.4  | 1.25              |                    |
| C                     | Offset error drift          |                         |                                     |            | 0.5   |                   | ppm/°C             |
| E <sub>G</sub> G      | Gain error                  |                         |                                     | -0.25      | -0.07 | 0.25              | %FSR               |
| G                     | Gain error drift            |                         |                                     |            | 0.3   |                   | ppm/°C             |
| CMRR C                | Common-mode r               | alaction ratio          | At dc                               |            | 70    |                   | dB                 |
|                       | common-mode i               |                         | $V_I = 1 V_{PP}$ at 1 MHz           |            | 50    |                   | uВ                 |
| Ν                     | Noise                       |                         |                                     |            | 33    |                   | $\mu V RMS$        |
| PSRR P                | Power-supply rej            | ection ratio            | At FFFFh output code <sup>(3)</sup> |            | 78    |                   | dB                 |
| SAMPLING              | G DYNAMICS                  |                         | T                                   | 1          |       | 1                 |                    |
| t <sub>CONV</sub> C   | Conversion time             |                         |                                     |            | 18    |                   | CCLK               |
| t <sub>SAMPLE</sub>   | Acquisition time            |                         | Manual trigger                      | 3          |       |                   | CCLK               |
| t <sub>SAMPLE</sub> 2 |                             |                         | Auto trigger                        |            | 3     |                   | UULN               |
| Т                     | Throughput rate             |                         |                                     |            |       | 500               | kHz                |
| A                     | Aperture delay              |                         |                                     |            | 5     |                   | ns                 |
| A                     | Aperture jitter             |                         |                                     |            | 10    |                   | ps                 |
| S                     | Step response               |                         |                                     |            | 100   |                   | ns                 |
| C                     | Overvoltage reco            | overy                   |                                     |            | 100   |                   | ns                 |

(1) Ideal input span, does not include gain or offset error.

(2) LSB means least significant bit.
(3) Measured relative to an ideal full-scale input [+IN – (–IN)] of 4.096 V when +VA = 5 V.



## **SPECIFICATIONS** (continued)

 $T_A = -40^{\circ}C$  to 85°C, +VA = 4.5 V to 5.5 V, +VBD = 1.65 V to 5.5 V,  $V_{REF} = 4.096$  V, and  $f_{SAMPLE} = 500$  kHz, unless otherwise noted.

|                   | PARAN   | NETER                | TEST CONDITI  | ONS                               | MIN           | TYP   | MAX           | UNIT |
|-------------------|---|----------------------|---|-----------------------------------|---------------|-------|---------------|------|
| DYNAMIC           | CHARACTERI  | STICS                |   |                                   |               |       |               |      |
|                   |   |                      | $V_{\text{IN}}$ = 4.096 $V_{\text{PP}}$ at 10 kHz                               |                                   |               | -96   |               |      |
| THD T             | Fotal harmonic d  | listortion (4)       | $V_{\text{IN}}$ = 4.096 $V_{\text{PP}}$ at 100 kHz,                             | ADS8327/28IB                      |               | -95.7 |               | dB   |
|                   |   |                      | $V_{\text{IN}}$ = 4.096 $V_{\text{PP}}$ at 100 kHz,                             | ADS8327/281                       |               | -95.7 |               |      |
| SNR S             | Pignal to poigo r                                       | otio                 | $V_{IN} = 4.096 V_{PP}$ at 10 kHz   |                                   |               | 91    |               | dB   |
| SINK C            | Signal-to-noise ratio                                   |                      | $V_{IN}$ = 4.096 $V_{PP}$ at 100 kHz  |                                   |               | 89    |               | uБ   |
|                   | Pienel te neiee i                                       | diatartian           | $V_{IN}$ = 4.096 $V_{PP}$ at 10 kHz   |                                   |               | 91    |               | 40   |
| SINAD S           | Signal-to-noise +                                       | - distortion         | V <sub>IN</sub> = 4.096 V <sub>PP</sub> at 100 kHz                              |                                   |               | 88    |               | dB   |
|                   |   |                      | V <sub>IN</sub> = 4.096 V <sub>PP</sub> at 10 kHz                               |                                   |               | 100   |               |      |
| SFDR S            | Spurious-free dy  | namic range          | V <sub>IN</sub> = 4.096 V <sub>PP</sub> at 100 kHz,                             | ADS8327/28IB                      |               | 98.8  |               | dB   |
|                   |   |                      | V <sub>IN</sub> = 4.096 V <sub>PP</sub> at 100 kHz,                             | ADS8327/281                       |               | 98.8  |               |      |
|                   | -3dB Small-signa  | al bandwidth         |   | 4                                 |               | 30    |               | MHz  |
| CLOCK             |   |                      |   |                                   | 1             |       |               |      |
| Ir                | nternal conversi  | on clock frequency   |   |                                   | 10.9          | 12    | 12.6          | MHz  |
|                   |   |                      | Used as I/O clock only  |                                   |               |       | 50            |      |
| S                 | SCLK External s   | erial clock          |   | As I/O clock and conversion clock |               |       | 21            | MHz  |
| EXTERNA           | L VOLTAGE RI  | EFERENCE INPUT       |   |                                   | I             |       |               |      |
| l,                | EF Input reference (REF+ - REF-)<br>range (REF-) - AGND |                      | 5.5 V ≥ +VA ≥ 4.5 V   |                                   | 0.3           | 4.096 | 4.2           |      |
| VDEE              |   |                      |   |                                   | -0.1          |       | 0.1           | V    |
| F                 | Resistance (5)  |                      | Reference input   |                                   | -             | 80    | -             | kΩ   |
|                   | NPUT/OUTPUT   |                      |   |                                   | 1             |       |               |      |
|                   | _ogic family—CN   | IOS                  |   |                                   |               |       |               |      |
|                   | High-level input  |                      | 5.5 V ≥ +VBD ≥ 4.5 V  |                                   | 0.65 × (+VBD) |       | +VBD + 0.3    | V    |
|                   | _ow-level input v                                       | -                    | 5.5 V ≥ +VBD ≥ 4.5 V  |                                   | -0.3          |       | 0.35 × (+VBD) | V    |
|                   | nput current  | onago                | $V_1 = +VBD$ or BDGND   |                                   | -50           |       | 50            | nA   |
| •                 | nput capacitance  | ۵                    |   |                                   |               | 5     | 00            | pF   |
|                   | High-level output                                       |                      | 5.5 V $\geq$ +VBD $\geq$ 4.5 V,<br>I <sub>O</sub> = 100 $\mu$ A                 |                                   | +VBD – 0.6    |       | +VBD          | V    |
| V <sub>OL</sub> L | _ow-level output  | voltage              | $5.5 \text{ V} \ge +\text{VBD} \ge 4.5 \text{ V},$<br>$I_0 = 100 \ \mu\text{A}$ |                                   | 0             |       | 0.4           | V    |
| c <sub>o</sub> c  | Output capacitar  | се                   |   |                                   |               | 5     |               | pF   |
| C <sub>L</sub> L  | _oad capacitanc   | e                    |   |                                   |               |       | 30            | pF   |
| C                 | Data format—str   | aight binary         |   |                                   |               |       |               |      |
| POWER-S           | UPPLY REQUI   | REMENTS              |   |                                   | 1             |       |               |      |
| F                 | Power supply  | +VBD                 |   |                                   | 1.65          | 3.3   | 5.5           | V    |
|                   | oltage  | +VA                  |   |                                   | 4.5           | 5     | 5.5           | V    |
|                   |   | 1                    | 500-kHz Sample rate   |                                   |               | 5     | 6.2           |      |
| S                 | Supply current  |                      | NAP/Auto-NAP mode   |                                   |               | 0.3   | 0.5           | mA   |
|                   | 11.7  |                      | Deep power-down mode  |                                   |               | 6     | 50            | nA   |
| F                 | Buffer I/O supply                                       | current              | 500 kSPS  |                                   |               | 1     |               | mA   |
| L                 |   |                      |   |                                   |               | 30    | 38.5          |      |
| F                 | Power dissipation                                       | n                    | +VA = 5 V, +VBD = 5 V<br>+VA = 5 V, +VBD = 1.8 V                                |                                   |               | 25.4  | 32            | mW   |
|                   | TURE RANGE  |                      | · •// = 0 •, • • 00 = 1.0 •   |                                   |               | 20.4  | 52            |      |
|                   |   | in to pop o noti uno |   |                                   | 40            |       | . 05          | •    |
| T <sub>A</sub> C  | Operating free-ai                                       | ir temperature       |   |                                   | -40           |       | +85           | °C   |

(4) Calculated on the first nine harmonics of the input frequency.

(5) Can vary ±30%

EXAS ISTRUMENTS

www.ti.com

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

## **TIMING CHARACTERISTICS**

All specifications typical at  $-40^{\circ}$ C to  $85^{\circ}$ C.  $+VA = 2.7 v. +VBD = 1.8 V^{(1)}$  (2)

|                                   | PARAMETER  |  | MIN  | TYP            | MAX                  | UNIT |
|-----------------------------------|--|--|------|----------------|----------------------|------|
|                                   |  | External,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> | 0.5  |                | 10.5                 |      |
| f <sub>CCLK</sub>                 | Frequency, conversion clock, CCLK  | Internal<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub>  | 10.5 | 11             | 12.2                 | MHz  |
| t <sub>su(CSF-EOC)</sub>          | Setup time, falling edge of $\overline{CS}$ to EOC                         |  | 1    |                |                      | CCLK |
| t <sub>h(CSF-EOC)</sub>           | Hold time, falling edge of $\overline{CS}$ to EOC                          |  | 0    |                |                      | ns   |
| t <sub>wL(CONVST)</sub>           | Pulse duration, CONVST low   |  | 40   |                |                      | ns   |
| t <sub>su(CSF-EOS)</sub>          | Setup time, falling edge of $\overline{CS}$ to EOS                         |  | 20   |                |                      | ns   |
| t <sub>h(CSF-EOS)</sub>           | Hold time, falling edge of $\overline{CS}$ to EOS                          |  | 20   |                |                      | ns   |
| t <sub>su(CSR-EOS)</sub>          | Setup time, rising edge of $\overline{CS}$ to EOS                          |  | 20   |                |                      | ns   |
| t <sub>h(CSR-EOS)</sub>           | Hold time, rising edge of $\overline{CS}$ to EOS                           |  | 20   |                |                      | ns   |
| t <sub>su(CSF-SCLK1F)</sub>       | Setup time, falling edge of $\overline{\text{CS}}$ to first falling SCLK   |  | 5    |                |                      | ns   |
| t <sub>wL(SCLK)</sub>             | Pulse duration, SCLK low   |  | 8    | t <sub>c</sub> | <sub>SCLK)</sub> – 8 | ns   |
| t <sub>wH(SCLK)</sub>             | Pulse duration, SCLK high  |  | 8    | t <sub>c</sub> | <sub>SCLK)</sub> – 8 | ns   |
|                                   |  | I/O Clock only   | 30   |                |                      |      |
|                                   |  | I/O and conversion clock                               | 47.6 |                | 2000                 |      |
| t <sub>c(SCLK)</sub>              | Cycle time, SCLK   | I/O Clock, chain mode                                  | 30   |                |                      | ns   |
|                                   |  | I/O and conversion clock, chain mode                   | 47.6 |                | 2000                 |      |
| t <sub>d(SCLKF</sub> -SDOINVALID) | Delay time, falling edge of SCLK to SDO invalid                            | 10-pF Load   | 7.5  |                |                      | ns   |
| t <sub>d(SCLKF</sub> -SDOVALID)   | Delay time, falling edge of SCLK to SDO valid                              | 10-pF Load   |      |                | 16                   | ns   |
| t <sub>d(CSF-SDOVALID)</sub>      | Delay time, falling edge of $\overline{CS}$ to SDO valid, SDO MSB output   | 10-pF Load   |      |                | 13                   | ns   |
| t <sub>su(SDI-SCLKF)</sub>        | Setup time, SDI to falling edge of SCLK                                    |  | 8    |                |                      | ns   |
| t <sub>h(SDI-SCLKF)</sub>         | Hold time, SDI to falling edge of SCLK                                     |  | 4    |                |                      | ns   |
| t <sub>d(CSR-SDOZ)</sub>          | Delay time, rising edge of $\overline{\text{CS}}/\text{FS}$ to SDO 3-state |  |      |                | 8                    | ns   |
| t <sub>su(16th</sub> SCLKF-CSR)   | Setup time, 16th falling edge of SCLK before rising edge of CS/FS          |  | 10   |                |                      | ns   |
| t <sub>d(SDO-CDI)</sub>           | Delay time, CDI high to SDO high in daisy chain mode                       | 10-pF Load, chain mode                                 |      |                | 25                   | ns   |

(1) All input signals are specified with  $t_r = t_f = 1.5$  ns (10% to 90% of V<sub>DD</sub>) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2. (2) See timing diagrams.



SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

## **TIMING CHARACTERISTICS**

All specifications typical at  $-40^{\circ}$ C to  $85^{\circ}$ C, +VA = +VBD = 5 V <sup>(1)</sup> <sup>(2)</sup>

|                                   | MIN  | TYP  | MAX  | UNIT           |           |      |
|-----------------------------------|--|--|------|----------------|-----------|------|
|                                   |  | External,<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub> | 0.5  |                | 10.5      |      |
| f <sub>CCLK</sub>                 | Frequency, conversion clock, CCLK  | Internal<br>f <sub>CCLK</sub> = 1/2 f <sub>SCLK</sub>  | 10.9 | 12             | 12.6      | MHz  |
| t <sub>su(CSF-EOC)</sub>          | Setup time, falling edge of $\overline{CS}$ to EOC                       |  | 1    |                |           | CCLK |
| t <sub>h(CSF-EOC)</sub>           | Hold time, falling edge of $\overline{CS}$ to EOC                        |  | 0    |                |           | ns   |
| t <sub>wL(CONVST)</sub>           | Pulse duration, CONVST low   |  | 40   |                |           | ns   |
| t <sub>su(CSF-EOS)</sub>          | Setup time, falling edge of $\overline{CS}$ to EOS                       |  | 20   |                |           | ns   |
| t <sub>h(CSF-EOS)</sub>           | Hold time, falling edge of $\overline{CS}$ to EOS                        |  | 20   |                |           | ns   |
| t <sub>su(CSR-EOS)</sub>          | Setup time, rising edge of $\overline{CS}$ to EOS                        |  | 20   |                |           | ns   |
| t <sub>h(CSR-EOS)</sub>           | Hold time, rising edge of $\overline{CS}$ to EOS                         |  | 20   |                |           | ns   |
| t <sub>su(CSF-SCLK1F)</sub>       | Setup time, falling edge of $\overline{\text{CS}}$ to first falling SCLK |  | 5    |                |           | ns   |
| t <sub>wL(SCLK)</sub>             | Pulse duration, SCLK low   |  | 8    | t <sub>c</sub> | SCLK) – 8 | ns   |
| t <sub>wH(SCLK)</sub>             | Pulse duration, SCLK high  |  | 8    |                | SCLK) - 8 | ns   |
| · · · ·                           |  | I/O Clock only   | 20   |                |           |      |
|                                   |  | I/O and conversion clock                               | 47.6 |                | 2000      |      |
| t <sub>c(SCLK)</sub>              | Cycle time, SCLK   | I/O Clock, chain mode                                  | 20   |                |           | ns   |
|                                   |  | I/O and conversion clock, chain mode                   | 47.6 |                | 2000      |      |
| t <sub>d(SCLKF</sub> -SDOINVALID) | Delay time, falling edge of SCLK to SDO invalid                          | 10-pF Load   | 2    |                |           | ns   |
| t <sub>d(SCLKF</sub> -SDOVALID)   | Delay time, falling edge of SCLK to SDO valid                            | 10-pF Load   |      |                | 10        | ns   |
| t <sub>d(CSF-SDOVALID)</sub>      | Delay time, falling edge of $\overline{CS}$ to SDO valid, SDO MSB output | 10-pF Load   |      |                | 8.5       | ns   |
| t <sub>su(SDI-SCLKF)</sub>        | Setup time, SDI to falling edge of SCLK                                  |  | 8    |                |           | ns   |
| t <sub>h(SDI-SCLKF)</sub>         | Hold time, SDI to falling edge of SCLK                                   |  | 4    |                |           | ns   |
| t <sub>d(CSR-SDOZ)</sub>          | Delay time, rising edge of CS/FS to SDO 3-state                          |  |      |                | 5         | ns   |
| t <sub>su(16th</sub> SCLKF-CSR)   | Setup time, 16th falling edge of SCLK before rising edge of CS/FS        |  | 10   |                |           | ns   |
| t <sub>d(SDO-CDI)</sub>           | Delay time, CDI high to SDO high in<br>daisy-chain mode                  | 10-pF Load, chain mode                                 |      |                | 16        | ns   |

(1) All input signals are specified with  $t_r = t_f = 1.5$  ns (10% to 90% of V<sub>DD</sub>) and timed from a voltage level of (V<sub>IL</sub> + V<sub>IH</sub>)/2. (2) See timing diagrams.

# ADS8327 ADS8328



www.ti.com

SLAS415E - APRIL 2006-REVISED JANUARY 2011

**PIN ASSIGNMENTS** ADS8327 ADS8328 **PW PACKAGE PW PACKAGE** (TOP VIEW) (TOP VIEW) 10 16 10 16 □ +VBD +VA [ +VBD +VA E RESERVED 2 15 2 15 SCLK +IN1 🎞 14 14 3 3 +IN 🗖 BDGND +IN0 🗖 🗖 BDGND 4 13 🗖 SDO СОМ 🗆 4 13 🗖 SDO AGND 🗖 AGND 🗖 5 12 🗖 SDI 5 12 REF-REF-6 11 FS/CS 11 FS/CS 6 REF+ (REFIN) 7 10 EOC/INT REF+ (REFIN) 7 10 EOC/INT CONVST 8 9 NC E 8 9 NC Г NC - No internal connection ADS8327 ADS8328 **RSA PACKAGE RSA PACKAGE** (TOP VIEW) (TOP VIEW) AGND AGND COM ONI+ REF. REF Ę ₹ 16 15 13 16 15 13 14 14 . REF+(REFIN) RESERVED REF+(REFIN) +IN1 (12(12 1 1 NC NC 2) (11 +VA 2) (11 +VA CONVST CONVST +VBD +VBD 3) (10 3) EOC/INT/CDI EOC/INT/CDI 4) 9 SCLK 4) 9 SCLK 8 7 6 7 6 8 5 5 FS/CS FS/CS SDO BDGND SDO BDGND SDI SDI

NC - No internal connection

**CAUTION:** The thermal pad is internally connected to the substrate. This pad can be connected to the analog ground or left floating. Keep the thermal pad separate from the digital ground, if possible.

10 Submit Documentation Feedback

© 2006–2011, Texas Instruments Incorporated



## SLAS415E – APRIL 2006 – REVISED JANUARY 2011

#### **ADS8327 Terminal Functions**

| NAME          | N     | 0.  | I/O | DESCRIPTION  |
|---------------|-------|-----|-----|--|
| NAME          | TSSOP | QFN | 1/0 | DESCRIPTION  |
| AGND          | 5     | 15  | -   | Analog ground  |
| BDGND         | 14    | 8   | _   | Interface ground   |
| CONVST        | 9     | 3   | I   | Freezes sample and hold, starts conversion with next rising edge of internal clock   |
| EOC/ INT/ CDI | 10    | 4   | 0   | Status output. If programmed as EOC, this pin is low (default) when a conversion is in progress. If programmed as an interrupt (INT), this pin is low for a preprogrammed duration after the end of conversion and valid data are to be output. The polarity of EOC or INT is programmable. This pin can also be used as a chain data input when the device is operated in chain mode. |
| FS/CS         | 11    | 5   | I   | Frame sync signal for TMS320 DSP serial interface or chip select input for SPI interface slave select (SS–).   |
| +IN           | 3     | 13  | I   | Noninverting input   |
| –IN           | 4     | 14  | I   | Inverting input, usually connected to ground   |
| NC            | 8     | 2   |     | No connection  |
| REF+          | 7     | 1   | I   | External reference input.  |
| REF-          | 6     | 16  | I   | Connect to AGND through individual via.  |
| RESERVED      | 2     | 12  | -   | Reserved, connect to AGND or +VA   |
| SCLK          | 15    | 9   | I   | Clock for serial interface   |
| SDI           | 12    | 6   | I   | Serial data in   |
| SDO           | 13    | 7   | 0   | Serial data out  |
| +VA           | 1     | 11  |     | Analog supply, +2.7 V to +5.5 VDC.   |
| +VBD          | 16    | 10  |     | Interface supply   |

## **ADS8328 Terminal Functions**

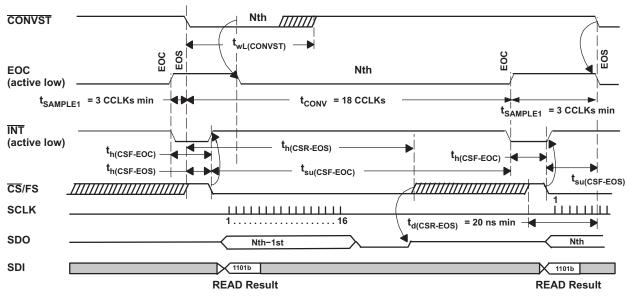
|                  | N     | 0.  | I/O | DECODIDION   |
|------------------|-------|-----|-----|--|
| NAME             | TSSOP | QFN | 1/0 | DESCRIPTION  |
| AGND             | 5     | 15  | -   | Analog ground  |
| BDGND            | 14    | 8   | -   | Interface ground   |
| СОМ              | 4     | 14  | I   | Common inverting input, usually connected to ground  |
| CONVST           | 9     | 3   | I   | Freezes sample and hold, starts conversion with next rising edge of internal clock   |
| EOC/ INT/<br>CDI | 10    | 4   | ο   | Status output. If programmed as EOC, this pin is low (default) when a conversion is in progress. If programmed as an interrupt (INT), this pin is low for a preprogrammed duration after the end of conversion and valid data are to be output. The polarity of EOC or INT is programmable. This pin can also be used as a chain data input when the device is operated in chain mode. |
| FS/CS            | 11    | 5   | I   | Frame sync signal for TMS320 DSP serial interface or chip select input for SPI interface   |
| +IN1             | 2     | 12  | I   | Second noninverting input.   |
| +IN0             | 3     | 13  | I   | First noninverting input   |
| NC               | 8     | 2   | _   | No connection.   |
| REF+             | 7     | 1   | I   | External reference input.  |
| REF-             | 6     | 16  | I   | Connect to AGND through individual via.  |
| SCLK             | 15    | 9   | I   | Clock for serial interface   |
| SDI              | 12    | 6   | I   | Serial data in (conversion start and reset possible)   |
| SDO              | 13    | 7   | 0   | Serial data out  |
| +VA              | 1     | 11  |     | Analog supply, +2.7 V to +5.5 VDC.   |
| +VBD             | 16    | 10  |     | Interface supply   |

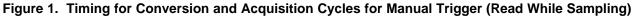
TEXAS INSTRUMENTS

SLAS415E – APRIL 2006 – REVISED JANUARY 2011

www.ti.com

MANUAL TRIGGER / READ While Sampling (use internal CCLK, EOC and INT polarity programmed as active low)





AUTO TRIGGER / READ While Sampling (use internal CCLK, EOC and INT polarity programmed as active low)

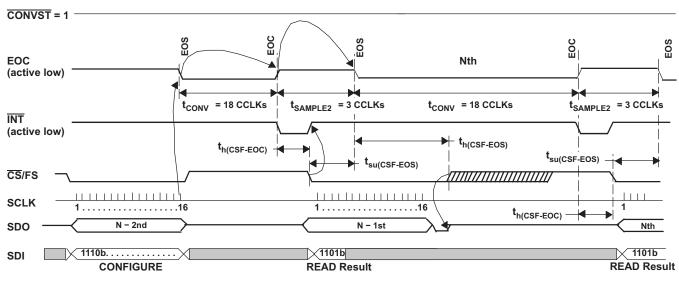
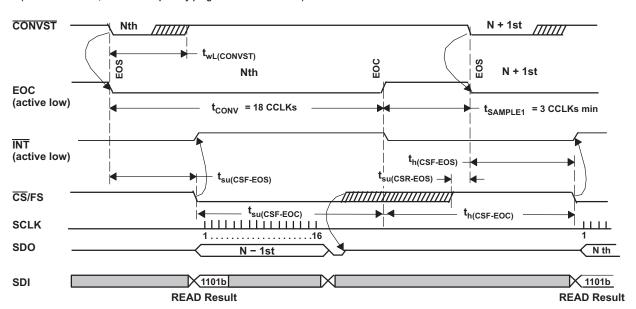


Figure 2. Timing for Conversion and Acquisition Cycles for Autotrigger (Read While Sampling)

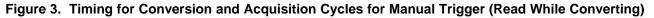


#### SLAS415E - APRIL 2006 - REVISED JANUARY 2011

#### www.ti.com



MANUAL TRIGGER / READ While Converting (use internal CCLK, EOC and INT polarity programmed as active low)



AUTO TRIGGER / READ While Converting (use internal CCLK, EOC and INT polarity programmed as active low)

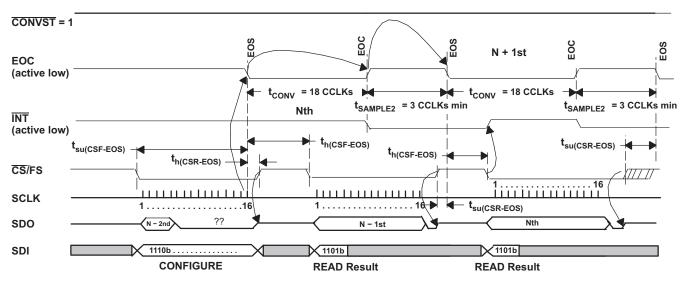


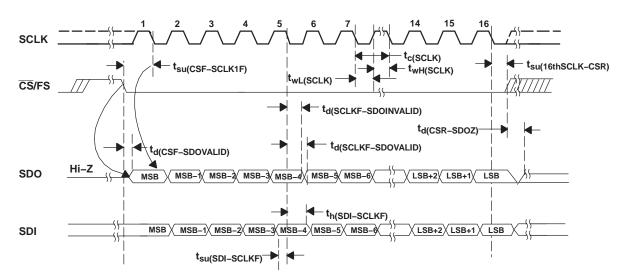
Figure 4. Timing for Conversion and Acquisition Cycles for Autotrigger (Read While Converting)

# ADS8327 ADS8328

TEXAS INSTRUMENTS

www.ti.com

## SLAS415E - APRIL 2006-REVISED JANUARY 2011





MANUAL TRIGGER / READ While Sampling (use internal CCLK active high, EOC and INT active low, TAG enabled, auto channel select) Nth CH0 Nth CH1 CONVST t<sub>wL(CONVST)</sub> t<sub>wL(CONVST)</sub> EOS 0 0 0 0 0 EOC Nth CH0 Nth CH1 (active low) t<sub>CONV</sub> = 18 CCLKs t<sub>CONV</sub> = 18 CCLKs t<sub>SAMPLE1</sub> = 3 CCLKs min INT (active low) t<sub>su(CSF-EOS)</sub> th(CSF-EOC) CS/FS . . . . . . . . . . . . . . . . . SCLK 17 17 1 . . . . . . . . . . . . . 16 t<sub>d(CSR-EOS)</sub> = 20 ns MIN Hi-Z Hi–Z SDO Nth CH0 N-1th CH1 TAG = 0 TAG = 1 SDI 1101ь Х 1101ь **READ Result READ Result** 



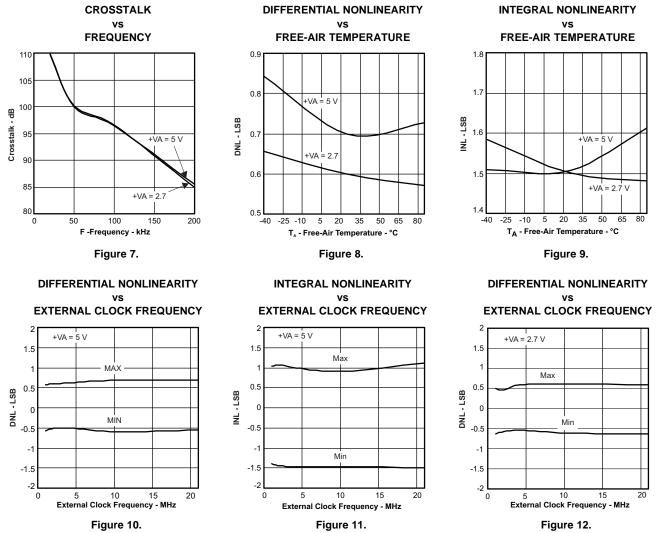


SLAS415E - APRIL 2006 - REVISED JANUARY 2011

#### www.ti.com

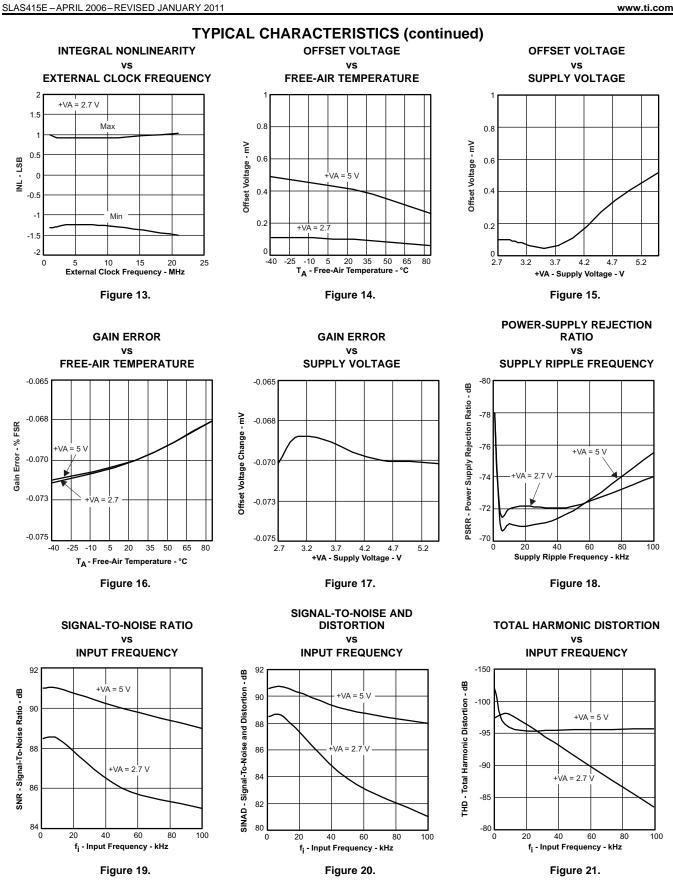
# **TYPICAL CHARACTERISTICS**

At -40°C to 85°C, V<sub>REF</sub> (REF+ - REF-) = 4.096 V when +VA = +VBD = 5 V or V<sub>REF</sub> (REF+ - REF-) = 2.5 V when +VA = +VBD = 2.7 V,  $f_{SCLK}$  = 21 MHz,  $f_I$  = DC for DC curves, and  $f_I$  = 100 kHz for AC curves, unless otherwise noted.



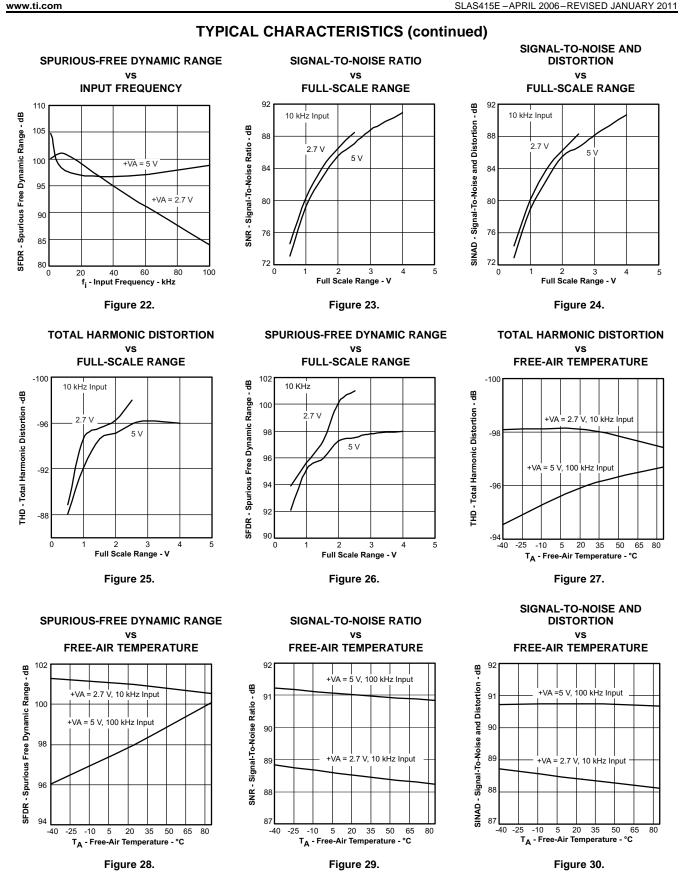
Texas NSTRUMENTS

www.ti.com



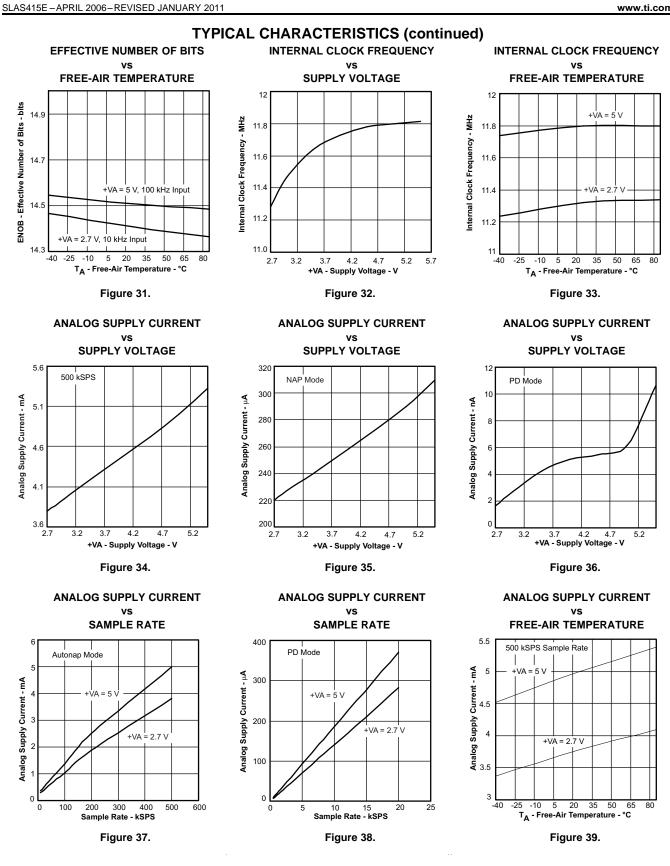


#### SLAS415E - APRIL 2006-REVISED JANUARY 2011



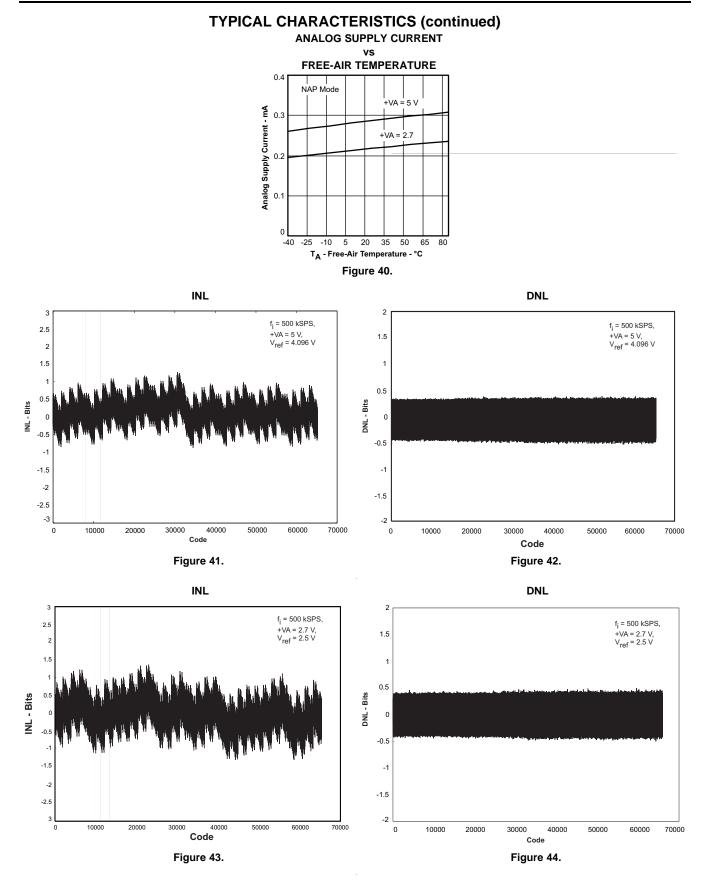
Texas **NSTRUMENTS** 

www.ti.com



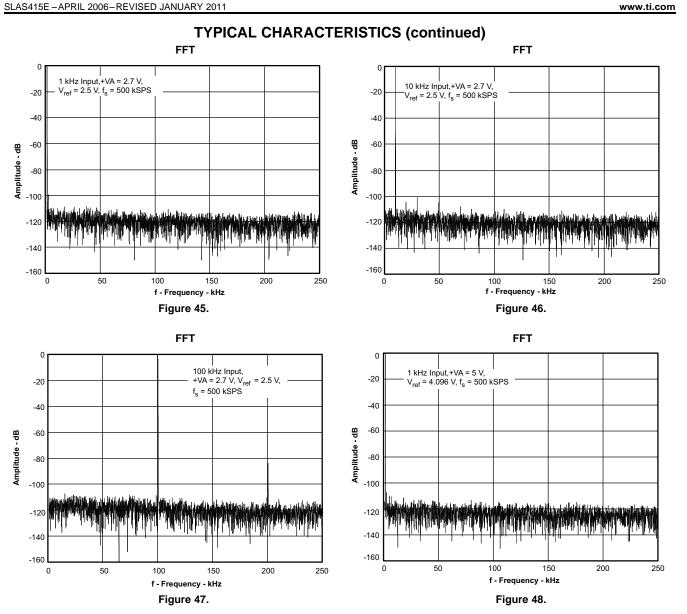


#### SLAS415E - APRIL 2006 - REVISED JANUARY 2011



ADS8327 ADS8328

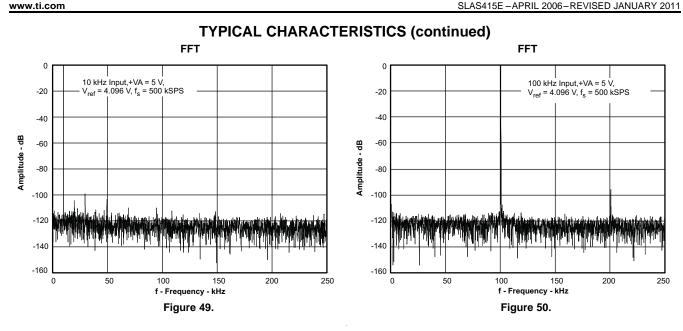
#### SLAS415E - APRIL 2006 - REVISED JANUARY 2011



Texas



#### SLAS415E - APRIL 2006-REVISED JANUARY 2011



THEORY OF OPERATION

The ADS8327/28 is a high-speed, low power, successive approximation register (SAR) analog-to-digital converter (ADC) that uses an external reference. The architecture is based on charge redistribution, which inherently includes a sample/hold function.

The ADS8327/28 has an internal clock that is used to run the conversion but can also be programmed to run the conversion based on the external serial clock. SCLK.

The ADS8327 has one analog input. The analog input is provided to two input pins; +IN and -IN. When a conversion is initiated, the differential input on these pins is sampled on the internal capacitor array. While a conversion is in progress, both +IN and -IN inputs are disconnected from any internal function.

The ADS8328 has two inputs. Both inputs share the same common pin-COM. The negative input is the same as the -IN pin for the ADS8327. The ADS8328 can be programmed to select a channel manually or can be programmed into the auto channel select mode to sweep between channel 0 and 1 automatically.

## ANALOG INPUT

When the converter enters hold mode, the voltage difference between the +IN and -IN inputs is captured on the internal capacitor array. The voltage on the -IN input is limited between AGND - 0.2 V and AGND + 0.2 V, allowing the input to reject small signals which are common to both the +IN and -IN inputs. The +IN input has a range of -0.2 V to V<sub>RFF</sub> + 0.2 V. The input span (+IN - (-IN)) is limited to 0 V to V<sub>RFF</sub>.

The (peak) input current through the analog inputs depends upon a number of factors: sample rate, input voltage, and source impedance. The current into the ADS8327/28 charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance (45 pF) to a 16-bit settling level within the minimum acquisition time (238 ns). When the converter goes into hold mode, the input impedance is greater than 1 GΩ.

Care must be taken regarding the absolute analog input voltage. To maintain linearity of the converter, the +IN and -IN inputs and the span (+IN - (-IN)) should be within the limits specified. Outside of these ranges, converter linearity may not meet specifications. To minimize noise, low bandwidth input signals with low-pass filters should be used. Care should be taken to ensure that the output impedance of the sources driving the +IN and -IN inputs are matched. If this is not observed, the two inputs could have different settling times. This may result in an offset error, gain error, and linearity error which change with temperature and input voltage.

© 2006–2011, Texas Instruments Incorporated

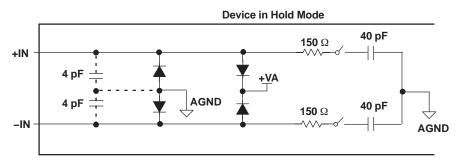


Figure 51. Input Equivalent Circuit

## **Driver Amplifier Choice**

The analog input to the converter needs to be driven with a low noise, op-amp like the THS4031 or OPA365 . An RC filter is recommended at the input pins to low-pass filter the noise from the source. Two resistors of  $20\Omega$  and a capacitor of 470 pF is recommended. The input to the converter is a unipolar input voltage in the range 0 V to V<sub>RFF</sub>. The minimum -3dB bandwidth of the driving operational amplifier can be calculated to:

 $f_{3db} = (ln(2) \times (n+1))/(2\pi \times t_{ACQ})$ 

where *n* is equal to 16, the resolution of the ADC (in the case of the ADS8327/28). When  $t_{ACQ} = 238$  ns (minimum acquisition time), the minimum bandwidth of the driving amplifier is 7.9 MHz. The bandwidth can be relaxed if the acquisition time is increased by the application. The OPA365, OPA827, or THS4031 from Texas Instruments are recommended. The THS4031 used in the source follower configuration to drive the converter is shown in the typical input drive configuration, Figure 52. For the ADS8330, a series resistor of 0 $\Omega$  should be used on the COM input (or no resistor at all).

## **Bipolar to Unipolar Driver**

In systems where the input is bipolar, the THS4031 can be used in the inverting configuration with an additional DC bias applied to its + input so as to keep the input to the ADS8327/28 within its rated operating voltage range. This configuration is also recommended when the ADS8327/28 is used in signal processing applications where good SNR and THD performance is required. The DC bias can be derived from the REF3225 or the REF3240 reference voltage ICs. The input configuration shown in Figure 53 is capable of delivering better than 91-dB SNR and -96-dB THD at an input frequency of 10 kHz. In case bandpass filters are used to filter the input, care should be taken to ensure that the signal swing at the input of the bandpass filter is small so as to keep the distortion introduced by the filter minimal. In such cases, the gain of the circuit shown in Figure 53 can be increased to keep the input to the ADS8327/28 large to keep the SNR of the system high. Note that the gain of the system from the + input to the output of the THS4031 in such a configuration is a function of the gain of the AC signal. A resistor divider can be used to scale the output of the REF3225 or REF3240 to reduce the voltage at the DC input to THS4031 to keep the voltage at the input of the converter within its rated operating range.

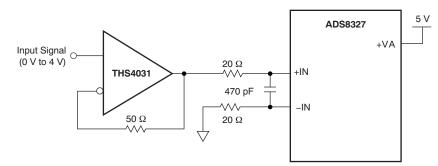


Figure 52. Unipolar Input Drive Configuration



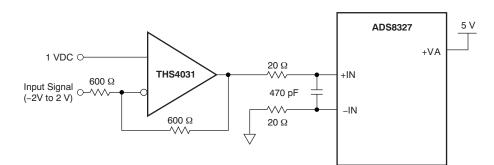


Figure 53. Bipolar Input Drive Configuration

## REFERENCE

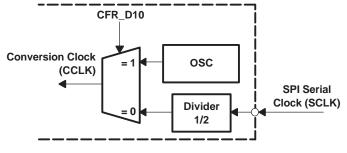
The ADS8327/28 can operate with an external reference with a range from 0.3 V to 4.2 V. A clean, low noise, well-decoupled reference voltage on this pin is required to ensure good performance of the converter. A low noise band-gap reference like the REF3240 can be used to drive this pin. A  $10-\mu$ F ceramic decoupling capacitor is required between the REF+ and REF– pins of the converter. These capacitors should be placed as close as possible to the pins of the device. REF– should be connected to its own via to the analog ground plane with the shortest possible distance.

## CONVERTER OPERATION

The ADS8327/28 has an oscillator that is used as an internal clock which controls the conversion rate. The frequency of this clock is 10.5 MHz minimum. The oscillator is always on unless the device is in the deep power-down state or the device is programmed for using SCLK as the conversion clock (CCLK). The minimum acquisition (sampling) time takes 3 CCLKs (this is equivalent to 238 ns at 12.6 MHz) and the conversion time takes 18 conversion clocks (CCLK) (~1500 ns) to complete one conversion.

The conversion can also be programmed to run based on the external serial clock, SCLK, if is so desired. This allows a system designer to achieve system synchronization. The serial clock SCLK, is first reduced to 1/2 of its frequency before it is used as the conversion clock (CCLK). For example, with a 21-MHz SCLK this provides a 10.5-MHz clock for conversions. If it is desired to start a conversion at a specific rising edge of the SCLK when the external SCLK is programmed as the source of the conversion clock (CCLK) (and manual start of conversion is selected), the setup time between CONVST and that rising SCLK edge should be observed. This ensures the conversion is complete in 18 CCLKs (or 36 SCLKs). The minimum setup time is 20 ns to ensure synchronization between CONVST and SCLK. In many cases the conversion can start one SCLK period (or CCLK) later which results in a 19 CCLK (or 37 SCLK) conversion. The 20 ns setup time is not required once synchronization is relaxed.

The duty cycle of SCLK is not critical as long as it meets the minimum high and low time requirements of 8 ns. Since the ADS8327/28 is designed for high-speed applications, a higher serial clock (SCLK) must be supplied to be able to sustain the high throughput with the serial interface and so the clock period of SCLK must be at most 1  $\mu$ s (when used as conversion clock (CCLK). The minimum clock frequency is also governed by the parasitic leakage of the capacitive digital-to-analog (CDAC) capacitors internal to the ADS8327/28.





SLAS415E - APRIL 2006-REVISED JANUARY 2011



www.ti.com

#### Manual Channel Select Mode

The conversion cycle starts with selecting an acquisition channel by writing a channel number to the command register (CMR). This cycle time can be as short as 4 serial clocks (SCLK).

## Auto Channel Select Mode

Channel selection can also be done automatically if auto channel select mode is enabled. This is the default channel select mode. The dual channel converter, ADS8328, has a built-in 2-to-1 MUX. If the device is programmed for auto channel select mode then signals from channel 0 and channel 1 are acquired with a fixed order. Channel 0 is accessed first in the next cycle after the command cycle that configured CFR\_D11 to 1 for auto channel select mode. This automatic access stops the cycle after the command cycle that sets CFR\_D11 to '0'.

## Start of a Conversion

The end of acquisition or sampling instance (EOS) is the same as the start of a conversion. This is initiated by bringing the CONVST pin low for a minimum of 40 ns. After the minimum requirement has been met, the <u>CONVST</u> pin can be brought high. CONVST acts independent of FS/CS so it is possible to use one common CONVST for applications requiring simultaneous sample/hold with multiple converters. The ADS8327/28 switches from sample to hold mode on the falling edge of the CONVST signal. The ADS8327/28 requires 18 conversion clock (CCLK) edges to complete a conversion. The conversion time is equivalent to 1500 ns with a 12-MHz internal clock. The minimum time between two consecutive CONVST signals is 21 CCLKs.

A conversion can also be initiated without using  $\overline{\text{CONVST}}$  if it is so programmed (CFR\_D9 = 0). When the converter is configured as auto trigger, the next conversion is automatically started three conversion clocks (CCLK) after the end of a conversion. These three conversion clocks (CCLK) are used as the acquisition time. In this case the time to complete one acquisition and conversion cycle is 21 CCLKs.

| MODE      | SELECT CHANNEL  | START CONVERSION                                       |
|-----------|---|--|
|           | Auto Channel Select <sup>(1)</sup>  | Auto Trigger   |
| Automatic | No need to write channel number to the CMR. Use internal sequencer for the ADS8328. | Start a conversion based on the conversion clock CCLK. |
| Manual    | Manual Channel Select   | Manual Trigger   |
| Manual    | Write the channel number to the CMR.  | Start a conversion with CONVST.                        |

#### Table 2. Different Types of Conversion

(1) Auto channel select should be used with auto trigger and also with the TAG bit enabled.

#### Status Output EOC/INT

When the status pin is programmed as EOC and the polarity is <u>set as active</u> low, the pin works in the following manner: The EOC output goes LOW immediately following CONVST going LOW when manual trigger is programmed. EOC stays LOW throughout the conversion process and returns to HIGH when the conversion has ended. The EOC output goes low for three conversion clocks (CCLK) after the previous rising edge of EOC, if auto trigger is programmed.

This status pin is programmable. It can be used as an EOC <u>output</u> (CFR.D[7:6] = 1, 1) where the low time is equal to the conversion time. This status pin can be used as INT. (CFR.D[7:6] = 1, 0) which is set LOW at the end of a conversion is brought to HIGH (cleared) by the next read cycle. The polarity of this pin, used as either function (EOC or INT), is programmable through CFR\_D7.



#### **Power-Down Modes**

The ADS8327/28 has a comprehensive built-in power-down feature. There are three power-down modes: Deep power-down mode, Nap power-down mode, and auto nap power-down mode. All three power-down modes are enabled by setting the related CFR bits. The first two power-down modes are activated when enabled. A wakeup command, 1011b, can resume device operation from a power-down mode. Auto nap power-down mode works slightly different. When the converter is enabled in auto nap power-down mode, an end of conversion instance (EOC) puts the device into auto nap power-down. The beginning of sampling resumes operation of the converter. The contents of the configuration register is not affected by any of the power-down modes. Any ongoing conversion when nap or deep power-down is activated is aborted.

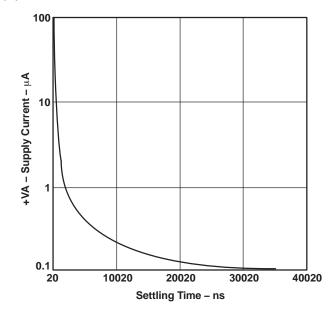


Figure 55. Typical Analog Supply Current Drop versus Time After Power-Down

SLAS415E - APRIL 2006-REVISED JANUARY 2011



www.ti.com

#### Deep Power-Down Mode

Deep power-down mode can be activated by writing to configuration register bit CFR\_D2. When the device is in deep power-down mode, all blocks except the interface are in power-down. The external SCLK is blocked to the analog block. The analog blocks no longer have bias currents and the internal oscillator is turned off. In this mode, supply current falls from 5 mA to 6 nA in 100 ns. The wake-up time after a power-down is 1  $\mu$ s. When bit D2 in the configuration register is set to 0, the device is in deep power-down. Setting this bit to '1' or sending a wake-up command can resume the converter from the deep power-down state.

#### Nap Mode

In nap mode the ADS8327/28 turns off biasing of the comparator and the mid-volt buffer. In this mode supply current falls from 5 mA in normal mode to about 0.3 mA in 200 ns after the configuration cycle. The wake-up (resume) time from nap power-down mode is 3 CCLKs (238 ns with a 12.6-MHz conversion clock). As soon as the CFR\_D3 bit in the control register is set to '0', the device goes into nap power-down mode, regardless of the conversion state. Setting this bit to '1' or sending a wake-up command can resume the converter from the nap power-down state.

#### Auto Nap Mode

Auto nap mode is almost identical to nap mode. The only difference is the time when the device is actually powered down and the method to wake up the device. Configuration register bit D4 is only used to enable/disable auto nap mode. If auto nap mode is enabled, the device turns off biasing after the conversion has finished, which means the end of conversion activates auto nap power-down mode. The supply current falls from 5 mA in normal mode to about 0.3 mA in 200 ns. A CONVST resumes the device and turns biasing on again in 3 CCLKs (238 ns with a 12.6-MHz conversion clock). The device can also be woken up by disabling auto nap mode when bit D4 of the configuration register is set to '1'. Any channel select command 0XXXb, wake-up command, or the set default mode command 1111b can also wake up the device from auto nap power-down.

## NOTE

- 1. This wake-up command is the word 1011b in the command word. This command sets bits D2 and D3 to 1 in the configuration register but not D4. But a wake-up command does remove the device from either one of these power-down states, deep/nap/auto nap power-down.
- 2. Wake-up time is defined as the time between when the host processor tries to wake up the converter and when a convert start can occur.

| TYPE OF<br>POWER-DOWN | POWER<br>CONSUMPTION | ACTIVATED BY            | ACTIVATION TIME | RESUME POWER BY  | RESUME TIME | ENABLE  |
|-----------------------|----------------------|-------------------------|-----------------|--|-------------|---------|
| Normal operation      | 5 mA/3.8 mA          |                         |                 |  |             |         |
| Deep power-down       | 6 nA/2 nA            | Setting CFR             | 100 ns          | Woken up by command 1011b  | 1 μs        | Set CFR |
| Nap power-down        | 0.3 mA/0.2 mA        | Setting CFR             | 200 ns          | Woken up by command 1011b to achieve 6.6 mA since $(1.3 + 12)/2 = 6.6$                           | 3 CCLKs     | Set CFR |
| Auto nap power-down   |                      | EOC (end of conversion) | 200 ns          | Woken up by CONVST, any channel select command, default command 1111b, or wake up command 1011b. | 3 CCLKs     | Set CFR |

## Table 3. Power-Down Mode Comparisons



SLAS415E - APRIL 2006 - REVISED JANUARY 2011

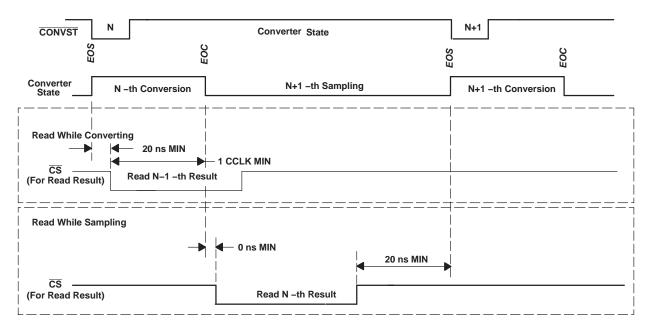


Figure 56. Read While Converting versus Read While Sampling (Manual trigger)

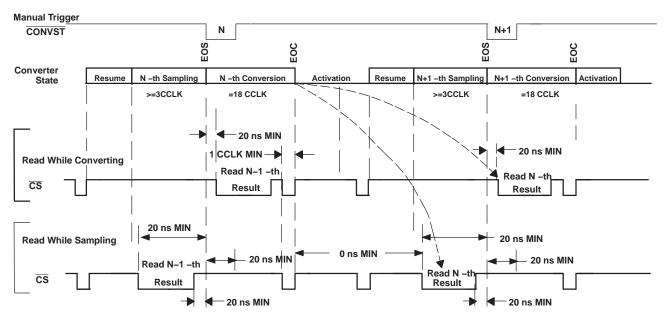


Figure 57. Read While Converting versus Read While Sampling with Deep or Nap Power-Down

# ADS8327 ADS8328



www.ti.com

NSTRUMENTS

Texas

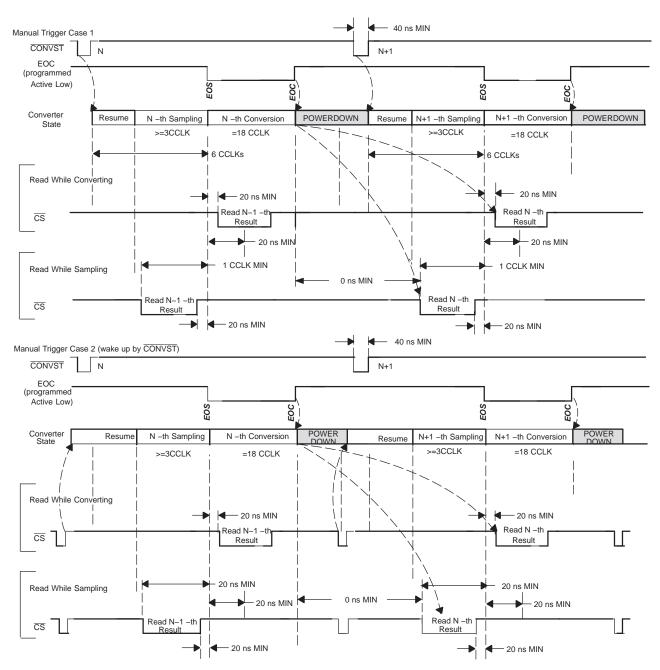


Figure 58. Read While Converting versus Read While Sampling with Auto Nap Power-Down



Total Acquisition + Conversion Cycle Time:

| Total Acquisition + Conversion Cycle Time. |  |  |  |  |
|--|--|--|--|--|
| Automatic:                                 | = 21 CCLKs   |  |  |  |
| Manual:                                    | ≥ 21 CCLKs   |  |  |  |
| Manual + deep<br>power-down:               | ≥ 4SCLK + 100 µs + 3 CCLK + 18 CCLK +16 SCLK + 1 µs                  |  |  |  |
| Manual + nap power-down:                   | ≥ 4 SCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK                        |  |  |  |
| Manual + auto nap<br>power-down:           | ≥ 4 SCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK (use wakeup to resume) |  |  |  |
| Manual + auto nap<br>power-down:           | ≥ 1 CCLK + 3 CCLK + 3 CCLK + 18 CCLK +16 SCLK (use CONVST to resume) |  |  |  |
|  |  |  |  |  |

## DIGITAL INTERFACE

The serial clock is designed to accommodate the latest high-speed processors with an SCLK frequency up to 50 MHz. Each cycle is started with the falling edge of FS/CS. The internal data register content which is made available to the output register at the EOC is presented on the SDO output pin at the falling edge of FS/CS. This is the MSB. Output data are valid at the falling edge of SCLK with  $t_{d(SCLKF-SDOVALID)}$  delay so that the host processor can read it at the falling edge. Serial data input is also read with the falling edge of SCLK.

The complete serial I/O cycle starts with the first falling edge of SCLK after the falling edge of FS/ $\overline{CS}$  and ends 16 (see NOTE) falling edges of SCLK later. The serial interface is very flexible. It works with CPOL = 0, CPHA = 1 or CPOL = 1, CPHA = 0. This means the falling edge of FS/ $\overline{CS}$  may fall while SCLK is high. The same relaxation applies to the rising edge of FS/ $\overline{CS}$  where SCLK may be high or low as long as the last SCLK falling edge happens before the rising edge of FS/ $\overline{CS}$ .

## NOTE

There are cases where a cycle is four SCLKs or up to 24 SCLKs depending on the read mode combination. See Table 4 for details.



#### SLAS415E - APRIL 2006-REVISED JANUARY 2011

#### Internal Register

The internal register consists of two parts, 4 bits for the command register (CMR) and 12 bits for configuration data register (CFR).

| D[15:12] | HEX | COMMAND                                      | D[11:0]    | WAKE UP FROM<br>AUTO NAP | MINIMUM SCLKs<br>REQUIRED | R/W |
|----------|-----|--|------------|--------------------------|---------------------------|-----|
| 0000b    | 0h  | Select analog input channel 0 <sup>(2)</sup> | Don't care | Y                        | 4                         | W   |
| 0001b    | 1h  | Select analog input channel 1 <sup>(2)</sup> | Don't care | Y                        | 4                         | W   |
| 0010b    | 2h  | Reserved                                     | Reserved   | _                        | -                         | _   |
| 0011b    | 3h  | Reserved                                     | Reserved   | -                        | -                         | -   |
| 0100b    | 4h  | Reserved                                     | Reserved   | -                        | -                         | _   |
| 0101b    | 5h  | Reserved                                     | Reserved   | -                        | -                         | _   |
| 0110b    | 6h  | Reserved                                     | Reserved   | _                        | -                         | _   |
| 0111b    | 7h  | Reserved                                     | Reserved   | -                        | -                         | -   |
| 1000b    | 8h  | Reserved                                     | Reserved   | -                        | -                         | -   |
| 1001b    | 9h  | Reserved                                     | Reserved   | -                        | -                         | _   |
| 1010b    | Ah  | Reserved                                     | Reserved   | -                        | -                         | _   |
| 1011b    | Bh  | Wake up                                      | Don't care | Y                        | 4                         | W   |
| 1100b    | Ch  | Read CFR                                     | Don't care | _                        | 16                        | R   |
| 1101b    | Dh  | Read data                                    | Don't care | _                        | 16                        | R   |
| 1110     | Eh  | Write CFR                                    | CFR Value  | _                        | 16                        | W   |
| 1111b    | Fh  | Default mode (load CFR with default value)   | Don't care | Y                        | 4                         | W   |

#### Table 4. Command Set Defined by Command Register (CMR)<sup>(1)</sup>

(1) When SDO is not in 3-state (FS/CS low and SCLK running), the bits from SDO are always part (depending on how many SCLKs are supplied) of the previous conversion result.

(2) These two commands apply to the ADS8328 only.

## WRITING TO THE CONVERTER

There are two different types of writes to the register, a 4-bit write to the CMR and a full 16-bit write to the CMR plus CFR. The command set is listed in Table 4. A simple command requires only 4 SCLKs and the write takes effect at the 4th falling edge of SCLK. A 16-bit write or read takes at least 16 SCLKs (see Table 7 for exceptions that require more than 16 SCLKs).

#### **Configuring the Converter and Default Mode**

The converter can be configuring with command 1110b (write to the CFR) or command 1111b (default mode). A write to the CFR requires a 4-bit command followed by 12-bits of data. A 4-bit command takes effect at the fourth falling edge of SCLK. A CFR write takes effect at the 16th falling edge of SCLK.

A default mode command can be achieved by simply tying SDI to +VBD. As soon as the chip is selected at least four 1s are clocked in by SCLK. The default value of the CFR is loaded into the CFR at the 4th falling edge of SCLK.

CFR default values are all 1s (except for CFR\_D1, this bit is ignored by the ADS8327 and is always read as a 0). The same default values apply for the CFR after a power-on reset (POR) and SW reset.



SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

# READING THE CONFIGURATION REGISTER

The host processor can read back the value programmed in the CFR by issuing command 1100b. The timing is similar to reading a conversion result except CONVST is not used and there is no activity on the EOC/INT pin. The CFR value read back contains the first four MSBs of conversion data plus valid 12-bit CFR contents.

| SDI BIT                                  | DEFINITION   |   |  |  |  |
|--|--|---|--|--|--|
| CFR - D[11 - 0]                          | DEFINITION   |   |  |  |  |
|  | Channel select mode  |   |  |  |  |
| D11 Default = 1                          | 0: Manual channel select enabled. Use channel select commands to access a different channel.                                     | 1: Auto channel select enabled. All channels are sampled and converted sequentially until the cycle after this bit is set to 0. |  |  |  |
|  | Conversion clock (CCLK) source select  |   |  |  |  |
| D10 Default = 1                          | 0: Conversion clock (CCLK) = SCLK/2  | 1: Conversion clock (CCLK) = Internal OSC   |  |  |  |
| D9 Default = 1                           | Trigger (conversion start) select: start conversion at the end of sampling (   | EOS). If D9 = 0, the D4 setting is ignored.   |  |  |  |
| D9 Delault = 1                           | 0: Auto trigger automatically starts (4 internal clocks after EOC inactive)  | 1: Manual trigger manually started by falling edge of CONVST  |  |  |  |
| D8 Default = 0                           | Don't care Don't care  |   |  |  |  |
| D7 Default = 1                           | Pin 10 polarity select when used as an output (EOC/INT)  |   |  |  |  |
| D7 Delault = 1                           | 0: EOC Active high/INT active high   | 1: EOC Active low/INT active low  |  |  |  |
| D6 Default = 1                           | Pin 10 function select when used as an output (EOC/INT)  |   |  |  |  |
| D6 Delault = 1                           | 0: Pin used as INT   | 1: Pin used as EOC  |  |  |  |
| D5 Default = 1                           | Pin 10 I/O select for chain mode operation   |   |  |  |  |
| D5 Delault = 1                           | 0: Pin 10 is used as CDI input (chain mode enabled)  | 1: Pin 10 is used as EOC/INT output   |  |  |  |
| D4 Default = 1                           | Auto nap power-down enable/disable (mid voltage and comparator shut down between cycles). This bit setting is ignored if D9 = 0. |   |  |  |  |
| D4 Delault = 1                           | 0: Auto nap power-down enabled (not activated)   | 1: Auto nap power-down disabled   |  |  |  |
| D3 Default = 1                           | Nap power-down (mid voltage and comparator shut down between cycles  | ). This bit is set to 1 automatically by wake-up command.   |  |  |  |
| D3 Default = 1                           | 0: Enable/activate device in nap power-down  | 1: Remove device from nap power-down (resume)   |  |  |  |
| D2 Default = 1                           | Deep power-down. This bit is set to 1 automatically by wake-up command.  |   |  |  |  |
| D2 Default = 1                           | 0: Enable/activate device in deep power-down   | 1: Remove device from deep power-down (resume)  |  |  |  |
| D1 Default =<br>0: ADS8327<br>1: ADS8328 | TAG bit enable. This bit is ignored by the ADS8327 and is always read 0.   |   |  |  |  |
|  | 0: TAG bit disabled.   | 1: TAG bit output enabled. TAG bit appears at the 17th SCLK.  |  |  |  |
| D0 Default = 1                           | Reset  |   |  |  |  |
|  | 0: System reset  | 1: Normal operation   |  |  |  |

## Table 5. Configuration Register (CFR) Map

## **READING CONVERSION RESULT**

The conversion result is available to the input of the <u>output</u> data register (ODR) at EOC and presented to the output of the output register at the next falling edge of CS or FS. The host processor can then shift the data out via the SDO pin any time except during the quiet zone. This is 20 ns before and 20 ns after the end of sampling (EOS) period. End of sampling (EOS) is defined as the falling edge of CONVST when manual trigger is used or the end of the 3rd conversion clock (CCLK) after EOC if auto trigger is used.

The falling edge of FS/CS should not be placed at the precise moment (minimum of at least one conversion clock (CCLK) delay) at the end of a conversion (by default when EOC goes high), otherwise the data are corrupt. If FS/CS is placed before the end of a conversion, the previous conversion result is read. If FS/CS is placed after the end of a conversion result is read.

The conversion result is 16-bit data in straight binary format as shown in Table 5. Generally 16 SCLKs are necessary, but there are exceptions where more than 16 SCLKS are required (see Table 7). Data output from the serial output (SDO) is left adjusted MSB first. The trailing bits are filled with the TAG bit first (if enabled) plus all zeros. SDO remains low until FS/CS is brought high again.

SDO is active when FS/CS is low. The rising edge of FS/CS 3-states the SDO output.



## N<u>OTE</u>

Whenever SDO is not in 3-state (when FS/CS is low and SCLK is running), a portion of the conversion result is output at the SDO pin. The number of bits depends on how many SCLKs are supplied. For example, a manual select channel command cycle requires 4 SCLKs, therefore 4 MSBs of the conversion result are output at SDO. The exception is SDO outputs all 1s during the cycle immediately after any reset (POR or software reset).

If SCLK is used as the conversion clock (CCLK) and a continuous SCLK is used, it is not possible to clock out all 16 SDO bits during the sampling time (6 SCLKs) because of the quiet zone requirement. In this case it is better to read the conversion result during the conversion time (36 SCLKs or 48 SCLKs in auto nap mode).

| DESCRIPTION                 | ANALOG VALUE               | DIGITAL OUTPUT      |          |
|-----------------------------|----------------------------|---------------------|----------|
| Full scale range            | V <sub>REF</sub>           | STRAIGHT BINARY     |          |
| Least significant bit (LSB) | V <sub>REF</sub> /65536    | BINARY CODE         | HEX CODE |
| Full scale                  | +V <sub>REF</sub> – 1 LSB  | 1111 1111 1111 1111 | FFFF     |
| Midscale                    | V <sub>REF</sub> /2        | 1000 0000 0000 0000 | 8000     |
| Midscale – 1 LSB            | V <sub>REF</sub> /2– 1 LSB | 0111 1111 1111 1111 | 7FFF     |
| Zero                        | 0 V                        | 0000 0000 0000 0000 | 0000     |

#### Table 6. Ideal Input Voltages and Output Codes

#### TAG Mode

The ADS8328 includes a feature, TAG, that can be used as a tag to indicate which channel sourced the converted result. An address bit is added after the LSB read out from SDO indicating which channel the result came from if TAG mode is enabled. This address bit is 0 for channel 0 and 1 for channel 1. The converter requires more than the 16 SCLKs that are required for a 4 bit command plus 12 bit CFR or 16 data bits because of the additional TAG bit.

## Chain Mode

The ADS8327/28 can operate as a single converter or in a system with multiple converters. System designers can take advantage of the simple high-speed SPI compatible serial interface by cascading them in a single chain when multiple converters are used. A bit in the CFR is used to reconfigure the EOC/INT status pin as a secondary serial data input, chain data input (CDI), for the conversion result from an upstream converter. This is chain mode operation. A typical connection of three converters is shown in Figure 59.

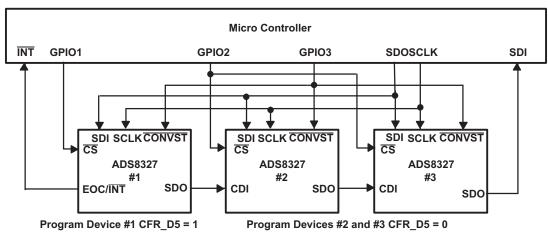
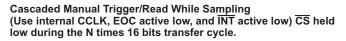


Figure 59. Multiple Converters Connected Using Chain Mode



When multiple converters are used in chain mode, the first converter is configured in regular mode while the rest of the converters downstream are configured in chain mode. When a converter is configured in chain mode, the CDI input data goes straight to the output register, therefore the serial input data passes through the converter with a 16 SCLK (if the TAG feature is disabled) or a 24 SCLK delay, as long as CS is active. See Figure 60 for detailed timing. In this timing the conversion in each converters are done simultaneously.



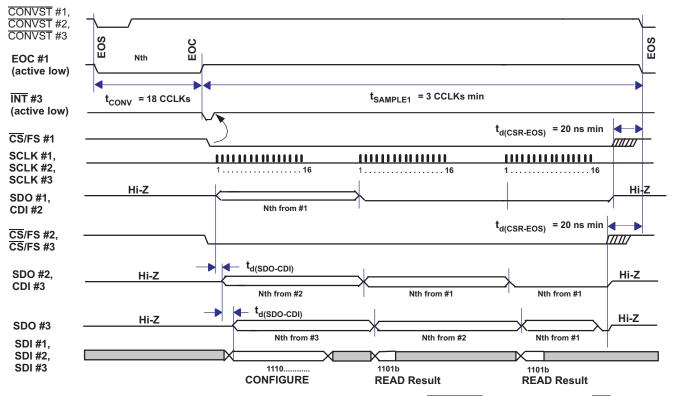


Figure 60. Simplified Cascade Mode Timing with Shared CONVST and Continuous CS

Care must be given to handle the multiple  $\overline{CS}$  signals when the converters are operating in chain mode. The different chip select signals must be low for the entire data transfer (in this example 48 bits for three converters). The first 16-bit word after the falling chip select is always the data from the chip that received the chip select signal.

Case 1: If chip select is not toggled ( $\overline{CS}$  stays low), the next 16 bits are data from the upstream converter, and so on. This is shown in Figure 60. If there is no upstream converter in the chain, as converter #1 in the example, the same data from the converter is going to be shown repeatedly.

Case 2: If the chip select is toggled during a chain mode data transfer cycle, as illustrated in Figure 61, the same data from the converter is read out again and again in all three discrete 16-bit cycles. This is not a desired result.

SLAS415E – APRIL 2006 – REVISED JANUARY 2011

www.ti.com

**INSTRUMENTS** 

Texas

Cascaded Manual Trigger/Read While Sampling (Use internal CCLK, EOC, and INT polarity programmed as active low) CS held low during the N times 16 bits transfer cycle.

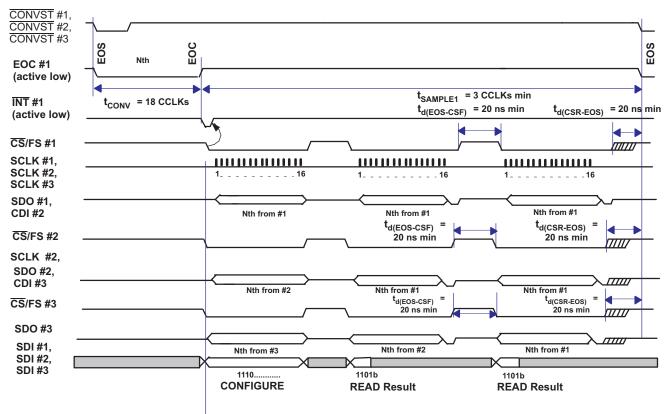


Figure 61. Simplified Cascade Mode Timing with Shared  $\overline{\text{CONVST}}$  and Discrete  $\overline{\text{CS}}$ 

Figure 62 shows a slightly different scenario where CONVST is not shared by the second converter. Converters #1 and #3 have the same CONVST signal. In this case, converter #2 simply passes previous conversion data downstream.



ADS8327 ADS8328

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

Cascaded Manual Trigger/Read While Sampling (Use internal CCLK, EOC active low and INT active low) CS held low during the N times 16 bits transfer cycle.

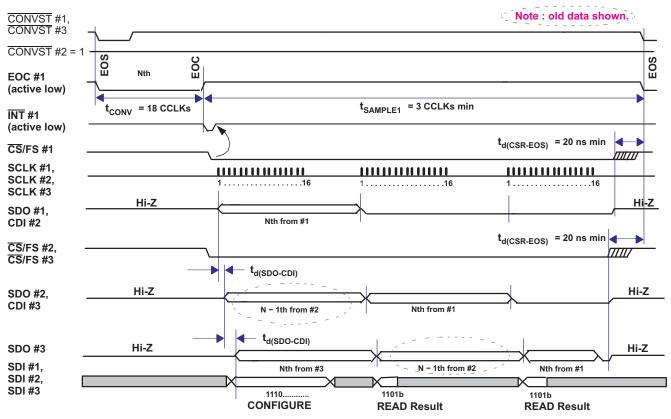


Figure 62. Simplified Cascade Timing (Separate CONVST)

The number of SCLKs required for a serial read cycle depends on the combination of different read modes, TAG bit, chain mode, and the way a channel is selected, i.e., auto channel select. This is listed in Table 7.

| CHAIN MODE<br>ENABLED CFR.D5 | AUTO CHANNEL<br>SELECT CFR.D11 | TAG ENABLED CFR.D1 | NUMBER OF SCLK PER SPI<br>READ | TRAILING BITS               |
|------------------------------|--------------------------------|--------------------|--------------------------------|-----------------------------|
| 0                            | 0                              | 0                  | 16                             | None                        |
| 0                            | 0                              | 1                  | ≥17                            | MSB is TAG bit plus zero(s) |
| 0                            | 1                              | 0                  | 16                             | None                        |
| 0                            | 1                              | 1                  | ≥17                            | TAG bit plus 7 zeros        |
| 1                            | 0                              | 0                  | 16                             | None                        |
| 1                            | 0                              | 1                  | 24                             | TAG bit plus 7 zeros        |
| 1                            | 1                              | 0                  | 16                             | None                        |
| 1                            | 1                              | 1                  | 24                             | TAG bit plus 7 zeros        |

| Table 7. Required SCLKs For Different Read Out Mode Combinations |
|--|
|--|

TEXAS INSTRUMENTS

#### SLAS415E – APRIL 2006 – REVISED JANUARY 2011

www.ti.com

SCLK skew between converters and data path delay through the converters configured in chain mode can affect the maximum frequency of SCLK. The delay can also be affected by supply voltage and loading. It may be necessary to slow down the SCLK when the devices are configured in chain mode.

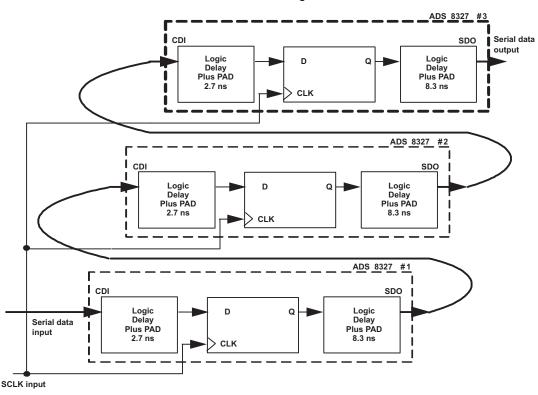


Figure 63. Typical Delay Through Converters Configured in Chain Mode

# RESET

The converter has two reset mechanisms, a power-on reset (POR) and a software reset using CFR\_D0. These two mechanisms are NOR-ed internally. When a reset (software or POR) is issued, all register data are set to the default values (all 1s) and the SDO output (during the cycle immediately after reset) is set to all 1s. The state machine is reset to the power-on state.

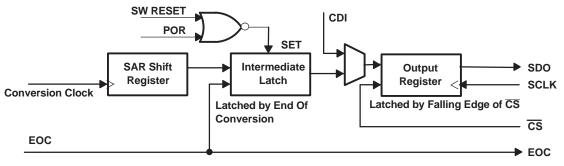


Figure 64. Digital Output Under Reset Condition



#### www.ti.com

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

When the device is powered up, the POR sets the device in default mode when AVDD reaches 1.5 V. When the device is powered down, the POR circuit requires AVDD to remain below 125 mV for a duration of at least 350 ms to ensure proper discharging of internal capacitors and to correct the behavior of the device when powered up again. If AVDD drops below 400 mV but remains above 125 mV, the internal POR capacitor does not discharge fully and the device requires a software reset to perform correctly after the recovery of AVDD (this is shown as the *undefined zone* in Figure 65).

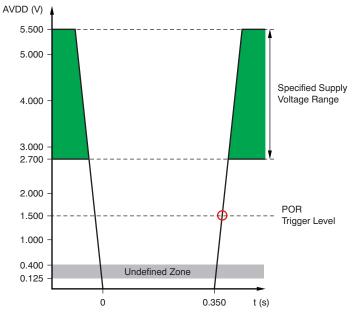


Figure 65. Relevant Voltage Levels for POR

TEXAS INSTRUMENTS

SLAS415E - APRIL 2006 - REVISED JANUARY 2011

www.ti.com

### **APPLICATION INFORMATION**

### **TYPICAL CONNECTION**

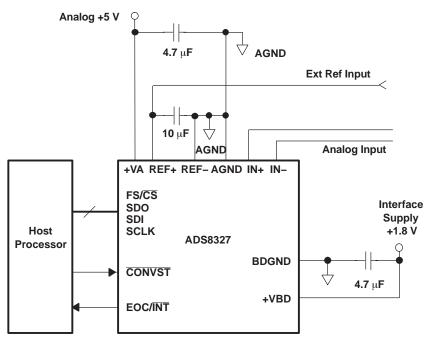


Figure 66. Typical Circuit Configuration

#### Part Change Notification # 20071101000

The ADS8327 and ADS8328 devices underwent a silicon change under Texas Instruments Part Change Notification (PCN) number 20071101000. Details on this part change can be obtained from the Product Information Center at Texas Instruments or by contacting your local sales/distribution office. Devices with a date code of **82xx** and higher are covered by this PCN.

### **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| C | hanges from Revision D (June 2009) to Revision E | Page |
|---|--|------|
| • | Updated Figure 60                                | 33   |
| • | Updated Figure 61                                | 34   |

#### Changes from Revision C (March 2008) to Revision D

| • | Added +REF to AGND and -REF to AGND specifications to Absolute Maximum Ratings table                                 | 3  |
|---|--|----|
| • | Revised conditions of 2.7 V to 3.6 V Specifications table to +VA = 2.7 V to 3.6 V and +VDB = 1.65 V to 1.5 × (+VA)   | 4  |
| • | Revised conditions of 2.7 V to 3.6 V Specifications table to +VA = 2.7 V to 3.6 V and +VDB = 1.65 V to 1.5 × (+VA)   | 5  |
| • | Changed test condition of Supply current, Nap mode row to NAP/Auto-NAP mode in 2.7 V to 3.6 V Specifications table   | 5  |
| • | Changed test condition of Supply current, PD Mode row to Deep power-down mode in Specifications table                | 5  |
| • | Revised conditions of 4.5 V to 5.5 V Specifications table to read +VA = 4.5 V to 5.5 V and +VDB = 1.65 V to 5.5 V    | 6  |
| • | Revised conditions of 4.5 V to 5.5 V Specifications table to read +VA = 4.5 V to 5.5 V and +VDB = 1.65 V to 5.5 V    | 7  |
| • | Changed test condition of Supply current, Nap mode row to NAP/Auto-NAP mode in 4.5 V to 5.5 V Specifications table   | 7  |
| • | Changed test condition of Supply current, PD Mode row to Deep power-down mode in 4.5 V to 5.5 V Specifications table | 7  |
| • | Corrected typo in Figure 1   | 12 |
| • | Updated SDO trace in Figure 2  | 12 |
| • | Changed N – 1th to N + 1st in CONVST trace of Figure 3   | 13 |
| • | Corrected EOC and SDO traces in Figure 4   | 13 |
| • | Added last sentence to Driver Amplifier Choice section   | 22 |
| • | Updated Figure 52  | 22 |
| • | Updated Figure 53  | 23 |
| • | Changed fifth sentence of the Deep Power-Down Mode section   | 26 |
| • | Changed second sentence of Nap Mode section  | 26 |
| • | Changed fifth sentence of Auto Nap Mode section  |    |
| • | Changed $\mu$ s to ns in Activation Time column of Table 3   | 26 |
| • | Added Figure 65 and corresponding paragraph to the RESET section   | 37 |



www.ti.com

#### Page

ADS8327

ADS8328

39



10-Dec-2020

### **PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| ADS8327IBPW      | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>83271 A<br>B     | Samples |
| ADS8327IBPWG4    | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>83271 A<br>B     | Samples |
| ADS8327IBPWR     | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>83271 A<br>B     | Samples |
| ADS8327IBRSAR    | ACTIVE        | QFN          | RSA                | 16   | 3000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8327I A          | Samples |
| ADS8327IBRSAT    | ACTIVE        | QFN          | RSA                | 16   | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8327I A          | Samples |
| ADS8327IPW       | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8327I A          | Samples |
| ADS8327IPWR      | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8327I A          | Samples |
| ADS8328IBPW      | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8328I A<br>B     | Samples |
| ADS8328IBPWG4    | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8328I A<br>B     | Samples |
| ADS8328IBRSAT    | ACTIVE        | QFN          | RSA                | 16   | 250            | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8328I A          | Samples |
| ADS8328IPW       | ACTIVE        | TSSOP        | PW                 | 16   | 90             | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8328I A          | Samples |
| ADS8328IPWR      | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green    | NIPDAU                               | Level-2-260C-1 YEAR  | -40 to 85    | ADS<br>8328I A          | Samples |

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.



10-Dec-2020

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |       |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      |       | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| ADS8327IBPWR                | TSSOP | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| ADS8327IBRSAR               | QFN   | RSA                | 16 | 3000 | 330.0                    | 12.4                     | 4.3        | 4.3        | 1.5        | 8.0        | 12.0      | Q2               |
| ADS8327IBRSAT               | QFN   | RSA                | 16 | 250  | 180.0                    | 12.4                     | 4.3        | 4.3        | 1.5        | 8.0        | 12.0      | Q2               |
| ADS8327IPWR                 | TSSOP | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| ADS8328IBRSAT               | QFN   | RSA                | 16 | 250  | 180.0                    | 12.4                     | 4.3        | 4.3        | 1.5        | 8.0        | 12.0      | Q2               |
| ADS8328IPWR                 | TSSOP | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

Texas Instruments

www.ti.com

## PACKAGE MATERIALS INFORMATION

22-Feb-2020



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS8327IBPWR  | TSSOP        | PW              | 16   | 2000 | 350.0       | 350.0      | 43.0        |
| ADS8327IBRSAR | QFN          | RSA             | 16   | 3000 | 350.0       | 350.0      | 43.0        |
| ADS8327IBRSAT | QFN          | RSA             | 16   | 250  | 210.0       | 185.0      | 35.0        |
| ADS8327IPWR   | TSSOP        | PW              | 16   | 2000 | 350.0       | 350.0      | 43.0        |
| ADS8328IBRSAT | QFN          | RSA             | 16   | 250  | 210.0       | 185.0      | 35.0        |
| ADS8328IPWR   | TSSOP        | PW              | 16   | 2000 | 350.0       | 350.0      | 43.0        |

## **MECHANICAL DATA**



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Quad Flatpack, No-leads (QFN) package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- F. Falls within JEDEC MO-220.



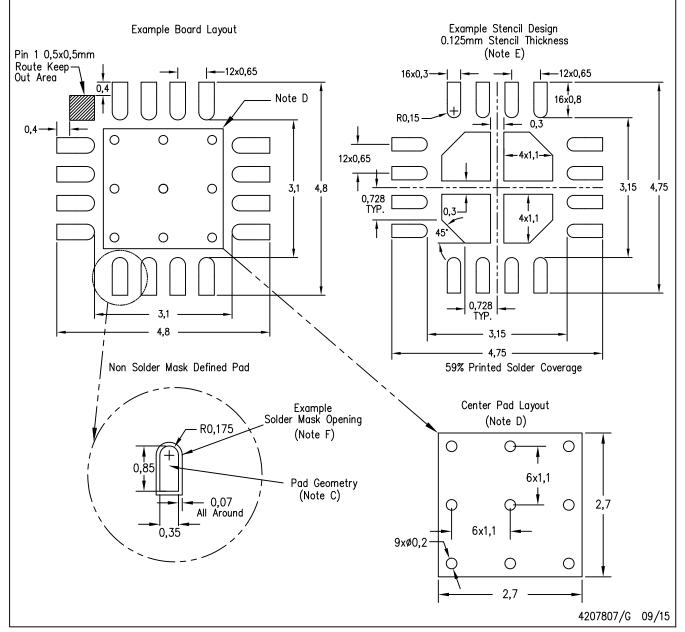


A. All linear dimensions are in millimeters



RSA (S-PVQFN-N16)

PLASTIC QUAD FLATPACK NO-LEAD



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, QFN Packages, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- $\mathsf{F}.$  Customers should contact their board fabrication site for solder mask tolerances.



# **PW0016A**



# **PACKAGE OUTLINE**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



# PW0016A

# **EXAMPLE BOARD LAYOUT**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# PW0016A

# **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

9. Board assembly site may have different recommendations for stencil design.



<sup>8.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2020, Texas Instruments Incorporated